

**University of Cincinnati**  
**Department of Electrical Engineering and Computing Systems**

**Felix: A *Better* Embedded Systems Development Kit**

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**Submitted in partial fulfillment of the degree of**

**Bachelors of Science in  
Electrical Engineering**



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## **DEDICATION**

To the various students, teachers, and mentors who have helped me along the way. I am lucky in that you are too numerous for me to thank each and every one of you individually.

To Dr. Carla Purdy, thank you for your kindness and flexibility in allowing me to work on this project remotely and especially thank you for sharing such wonderful stories of your career and life.

To Dr. Jason Heikenfeld, thank you for your support and guidance. Without it, I would not have been able to undertake this project while traveling and studying abroad.

To my friends, Nicholas and Sarah Twine, Tristan Morphew, Adina McClelland, Dr. Andrew Jajack, Alva Webster, Mikaila Wenker, Sarah Frey, and Michael Takahashi, thank you all for your constant support when I was down.

To Zach Matson, thank you for always being the voice of reason and pushing me to improve education by simplifying resources and expanding educational opportunities. And thank you for being my mentor and close friend.

To my parents, thank you for your constant support and guidance when times were hard.

To Dr. Teri Murphy, thank you for your kind and ample enthusiasm for this project, even in the midst of personal challenges (and triumphs!).

To Dr. Rui Dai, thank you for taking a risk on me and allowing your students to be test subjects for this project as part of their curriculum and for even considering this as a viable replacement.

To my students, thank you for being test subjects and for giving honest feedback.

... and to everyone whose name I could not mention. Your sacrifice does not go unrecognized.

Thank you all.

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## **Abstract**

At the University of Cincinnati, all electrical and computer engineers have to take a course titled Embedded Systems Development that requires them to purchase an expensive and out of date system. The proposed system is dramatically cheaper and more powerful and expands the educational opportunities of the course.

## **INTRODUCTION**

### **Problem/Need**

Students in Embedded Systems Design currently pay too much for a rigid system that limits the educational opportunities of the course. The current system involves two development kits (Parallax BasicStamp HomeWork Board and Microchip Curiosity Board) that are limited in power and architecture.

Ten undergraduate electrical and computer engineering students, a mix of both current and alumni, were asked about their opinions on the current system and suggestions for a suitable platform. All resented the current kits for their cost and limitations, such as computational power constraints. Of the three professors surveyed, there were many requests: more computational power, specifically enough for an FFT; further life beyond the course, specifically in senior design; and cost reduction, so students can work individually on projects.

When given better tools to learn, students are set up for greater success. Keeping costs low and supplying better, more powerful tools are ways for both students and the university to stay competitive as education becomes more demanding.

The current system is suboptimal simply due to lack of maintenance and the lack of resources that could be devoted to solving this issue. This is the result of time constraints due to faculty and staff responsibilities, which transfers to the students as a monetary burden.

### **Solution**

The proposed embedded systems development kit is a better solution because it uses a modern architecture chip that is likely to be on the market longer and has greater computational capabilities (operating frequency, memory, amount of GPIO, peripherals). Its modularity helps to reduce cost, teaches a new skill to students (soldering), and extends the use of individual components beyond the course. The board assembly process allows students to wire their device once, and then focus on the programming and architecture aspects of embedded systems instead of continually diagnosing wiring problems.

The implemented microcontroller should have the following capabilities:

- Hardware communication (UART, I2C, SPI, etc.)
- Analog to digital conversion

- Adequate number of GPIO pins
- Low power/sleep
- EEPROM/hard memory storage
- Programmable with Assembly and C/C++

Multiple microcontrollers were considered for this application, including the ARM Cortex-M0, ATmega328P, Cypress PSoC, Intel 8051, PIC 16F1619, and PIC 18F24K40[3]. They were evaluated based on cost, computational power, memory size, peripherals, lifetime, applicability to coursework, industrial applications, and usability. The PIC 18F24K40 was selected for its broad superiority in these categories.

The boards will be composed entirely of through-hole components so that students with limited to no soldering experience will be able to assemble their boards with limited difficulty. The soldering should not affect the current timeline of the course, as lab currently does not take place the first few weeks of the semester. This time could be used for teaching soldering and assembling boards. Since students will assemble their own boards, they will have the necessary skills to replace individual components in the event of a failure. Having a modular design furthers this compartmentalization of failure by limiting what parts can individually break in the system and reducing the likelihood and cost of a failure. If a part does break, it will not compromise the entire system, and the individual component or module is likely replaceable instead of replacing the whole system.

The solution will be a set of design files representing all the printed circuit boards, a bill of materials listing all the necessary components, documentation of all circuit schematics and layouts, and a set of laboratories to test students' abilities to perform specific skills. These items could be sold as a complete kit at scale or purchased at the individual level by students direct from manufacturers/suppliers. All components are easily sourced through major suppliers such as Digikey, Mouser, or Element14, and PCBs can be ordered directly from a multitude of low-volume board houses such as JLB PCB, OSH Park, or PCB Way.

The university could also purchase components at reduced prices, dropping the overall price for students significantly and providing an immediate stock of components if a replacement part is needed.

### **Credential**

This project will require more than basic engineering design skills, but also an understanding of the logistics and psychology involved in the educational process. Knowledge of useful pedagogies and empathic design processes will assist in producing a product that is useful to the final user, the students.

Ryan Michael Norton:

University of Cincinnati, Class of 2019: BS. Electrical Engineering (Minor: Mathematics)

- Lecture Assistant for Calculus II

- Embedded System Design (Grade Received: A)
- User-Centered Design (Grade Received: A-)
- STEM Education and Practices (Grade Received: A)

Big Ass Fans: Research and Development Engineer for Control Systems (Summer 2016)

- Led multidisciplinary team to develop a high bandwidth data logging platform/kit for non-engineering researchers within the company
- Developed hardware solutions for customs communication with industrial systems

Happy Nerd Company, LLC: Owner / Operator (Spring 2016 – Present)

- Develop hardware solutions for low risk medical environments and data logging
- Full stack web developer/designer with focus in eCommerce and business growth

University of Cincinnati, Novel Device Lab: Engineering Research Assistant (Spring 2017)

- Built test rigs for measuring and limiting effects of humidity on hydrophilicity of chemically functionalized surfaces
- Award for Best Co-op Research Presentation because of innovative style of presentation

Tesla Motor Company, Gigafactory 1: Design Management Engineer (Summer 2018)

- Developed statistical models to determine factory failure modes and likelihoods
- Developed advanced staffing model to predict hiring needs over the next decade

## **Project Goals**

Students who take embedded system design are currently required to purchase kits that have little to no use beyond the scope of the course, are expensive, and limit the educational opportunity the course can offer.

The proposed solution is a cheaper, more flexible, more powerful kit that helps keep student cost low, improves the educational opportunities, and encourages use beyond the scope of the course.

## **Methodology**

### Pedagogical Approach

The Dreyfus model of learning[2] states that, when learning a new subject, there are five stages of thought development all people exhibit:

1. Novice – needs exact instructions
2. Advanced Beginner – can work on their own, has difficulty troubleshooting/diagnosing
3. Competent – works from concepts, troubleshoots, and solves problems
4. Proficient – understands larger context within the problem
5. Expert – seeks new knowledge, writes books, does research

Ideally, students would go from novice to expert in the span of three months, but that is just too much to ask of any individual. It would be considered a resounding success to get all students

from novice to competent. With enough information, students can then make informed decisions to continue their studies in embedded systems or pursue other paths.

The point of this model is not to create a pedagogical goal, rather to show that there are steps that all students will naturally follow on their path to competency. The educational system should facilitate this kind of growth, not fight it.

### Current System

The BasicStamp Homework board is a small surface mounted system with 16 digital-only IO pins that exclusively runs PBASIC, a version of BASIC designed to run on the PIC system. The ideology behind this board is that students do not have to learn complex programming early on and can focus on embedded systems control schemas. Unfortunately, because of the simplicity of the board, it is slow, can not hold a large program, and is limited in capability. The nature of this board ultimately limits students down the line by wasting their time and money on a limited system.

The Microchip Curiosity board runs modern C++/Assembly instead of BASIC. Unfortunately, the development board trades off convenience for flexibility and power. The In-Circuit Serial Programmer (ICSP), which can be expensive, is built into the board, limiting its use to program only the chip on the Curiosity board. This limitation, combined with others such as pre-wired peripherals (i.e. sensors/output permanently wired to certain IO), can unnecessarily confuse students and make important topics seem abstract.

What the BasicStamp Homework board gets is that students require an elementary understanding in order to begin to learn. While its simplicity allows for a low barrier for entry, it also means that as students progress and enter the ‘Advanced Beginner’[2] stage, they quickly outgrow the board, requiring more control of and complexity in the system. The current response to this is to then transition to using the Curiosity board.

The problem is that the Curiosity board is too much of a jump, as it is really designed for use by those in the ‘Competent’[2] stage and above. Predetermined IO and a built-in programmer are two examples of things that can frustrate and confuse students only in the ‘Advanced Beginner’[2] stage of their embedded systems education. The system needs to grow as the student does and present new challenges as the student reaches new successes. It has to match them at every stage. Too far ahead and students won’t be able to engage, too far behind, and the students will become disinterested.

The proposed system provides better value and educational opportunity for students. The lower cost of the components helps students achieve a greater return on investment for their education.

Modularity increases the value of the kit as well as the flexibility and number of uses, even at its reduced cost. This compartmentalizes failures of the system and facilitates replacement of individual parts, allowing for repair of the system.

Since the system is has more capability, teachers can challenge students further, improving the educational experience for both the teacher and the student. Students will be exposed to the important skill of soldering, while teachers are free to add/remove different modules in order to improve and refine the system without creating significant changes to the curriculum.

## DISCUSSION

### Project Concept

A cheaper, custom development kit designed with cost and power in mind would help alleviate financial strain on students and provide a more open platform for development, exploration, and education within the purview of embedded systems. Given the low cost of custom printed circuit boards and electrical components, a kit could easily be designed to significantly lower costs and improve capabilities.

### Design Objectives

#### Objectives

- Lower cost from current system
- Raise value compared to current system
- Increase computational power (for students to explore more)
- Be safe and easy to use
- Expand educational goals of the course
- Keep students engaged with low level programming techniques and principles

#### Functions

- Reading Datasheets
- Assembly
- C/C++
- Controlling I/O
  - Digital Inputs
    - Debouncing
    - Reading States
  - Digital Out
  - Analog In
    - Analog to Digital Conversion
  - Analog Out
    - CCP/PWM
- Interrupts
- Communication

- Serial (USB to Serial)
- I2C
- Memory
  - EEPROM
- Timers
- Power Consumption
  - Sleep Mode
  - Battery Life
- Skills
  - Linear Mapping of Numbers
  - Bit Shifting/Bit Masking
  - Soldering
  - Control Schemas
    - Multiplexing
    - Servos
  - PCB Layout, Milling, and Sourcing
- Easily portable
- Useful beyond the scope of educational courses (Reusable)
- High Computational Power

#### Constraints

- Low Cost (<\$50)
- Safe to use
- Solderable by Amateurs

#### Means

- Modular design through PCB compartmentalization
- Only through hole components and large surface mounted components
- Simple circuits without extraneous protection
- Low voltage (5V-3V3)
- PIC Processor

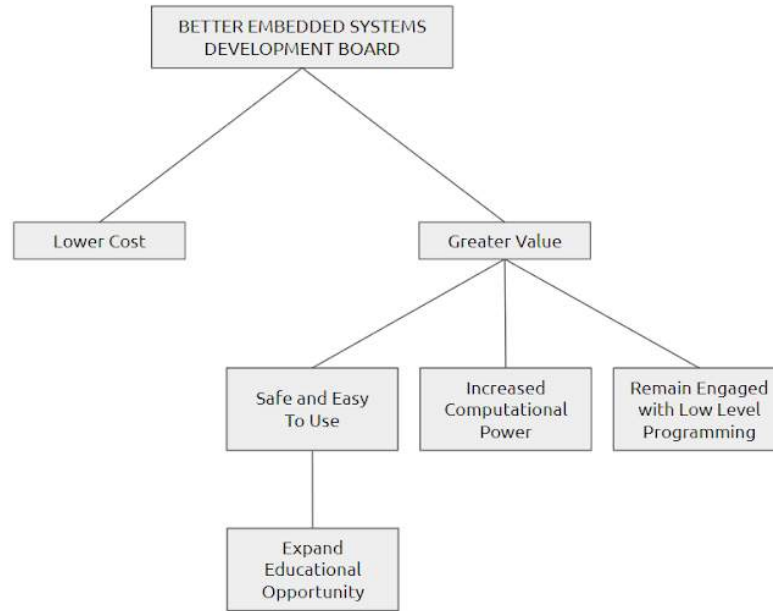


Figure 1. Objective Tree

## Technical Approach

Felix was designed to improve a course that relied on an old and inflexible development system to teach embedded systems. The goal was a more powerful, more intuitive, and cheaper embedded systems development kit. It is similar to an Arduino Uno but with more power and control.

Over the course of several months, constraints and goals were specified, the board layout was paper crafted, countless design iterations, renderings, and critique sessions were conducted. The modular system that was developed is already generating excitement from professors and engineering students alike.

To test this system, a small group of students will be introduced and observed using it, with the help of Dr. Carla Purdy and Dr. Rui Dai at the University of Cincinnati. This project will improve the education of electrical and computer engineering students as they engage with embedded systems and their applications. Not only will the proposed system provide more power and capabilities, it does so at a lower cost for students.

This helps to lower the barrier for entry and potentially open the course to students that otherwise could not afford to participate. Improving the education process ripples out into industry *and* academia. When people are given the tools and opportunities to be successful, society at large reaps the rewards of their discoveries and innovations.

**Budget / Bookkeeping**

Order Description	Purchaser	Supplier	Cost	Ship	Tax	Tarriff	Total	Category
Breadboards and Male Header Pins	Ryan Norton	Amazon	\$ 18.98	\$ -	\$ -	\$ -	\$ 18.98	Circuit Boards
Various Components	Happy Nerd Company, LLC	Digi-Key Electronics	\$ 222.14	\$ 14.55	\$ 14.20	\$ -	\$ 250.89	Components
Various Components	Happy Nerd Company, LLC	Farnell UK	\$ 81.62	\$ 13.66	\$ -	\$ -	\$ 95.28	Components
Circuit Boards version 2	Ryan Norton	JLC PCB	\$ 51.00	\$ 35.93	\$ 45.03	\$ -	\$ 131.96	Circuit Boards
Circuit Boards version 3	Ryan Norton	JLC PCB	\$ 44.00	\$ 20.87	\$ -	\$ -	\$ 64.87	Circuit Boards
Circuit Boards version 4	Ryan Norton	JLC PCB	\$ 7.00	\$ 24.97	\$ -	\$ -	\$ 31.97	Circuit Boards
Screwdriver	Ryan Norton	Wilko	\$ 0.46	\$ -	\$ -	\$ -	\$ 0.46	Tools
Various Components	Happy Nerd Company, LLC	Digi-Key Electronics	\$ 50.89	\$ 3.06	\$ -	\$ 24.72	\$ 78.67	Components
Circuit Boards version 1	Happy Nerd Company, LLC	JLC PCB	\$ 3.97	\$ 37.34	\$ -	\$ -	\$ 41.31	Circuit Boards
Digital Multimeter	Ryan Norton	Wilko	\$ 15.63	\$ -	\$ -	\$ -	\$ 15.63	Tools
220V Soldering Iron, Screwdrivers	Ryan Norton	Wilko	\$ 27.94	\$ -	\$ -	\$ -	\$ 27.94	Tools
Flush Cutters	Ryan Norton	Amazon	\$ 7.81	\$ -	\$ -	\$ -	\$ 7.81	Tools
Various Components	Ryan Norton	Digi-Key Electronics	\$ 141.41	\$ 14.85	\$ -	\$ -	\$ 156.26	Components
<b>Total Project Cost</b>							<b>\$ 922.03</b>	
<i>Budget</i>							\$ 1,000.	
<i>Remaining</i>							\$ 77.97	

Figure 2. Bookkeeping

**Bill of Materials**

Part	Value	Manufacturer Part Number	Unit Cost	No.	Cost
Display	4x7 Segment	LTC-4727JR	\$3.96	1	\$3.96
Female Header	6 Pin	PPTC061LFBN-RC	\$0.52	7	\$3.64
Resistors	1k, Small	CF18JT1K00	\$0.10	30	\$3.00
UART USB Bridge	MCP 2221	MCP2221-I/P	\$2.60	1	\$2.60
Smoothing Caps	0.1 uF	RD71H104K0P1H03B	\$0.29	7	\$2.03
Male Header	6 Pin	M20-9770646	\$0.25	8	\$2.00
LEDs	Green	151031VS06000	\$0.16	12	\$1.92
USB Port	Mini B	548190519	\$1.64	1	\$1.64
LEDs	Red	151031SS04000	\$0.18	9	\$1.62
Microcontroller	PIC18F24K40	PIC18F24K40-I/SP	\$1.52	1	\$1.52
Rotary Encoder	EN11-HSM1AF15	EN11-HSM1AF15	\$1.25	1	\$1.25
Switch	2PDT	MHSS1104	\$0.54	2	\$1.08
Real Time Clock	MCP 7940M	MCP7940M-I/P	\$0.66	1	\$0.66
Potentiometer	10k	P120PK-Y25BR10K	\$0.63	1	\$0.63
Oscillator Caps	15 pF	SR152A150KAR	\$0.31	2	\$0.62
Decoder	3x8 Active Low	CD74HC238E	\$0.60	1	\$0.60
Buzzer	WT-1205	WT-1205	\$0.54	1	\$0.54
Boards	Assorted	---	\$0.50	1	\$0.50
Crystal Oscillator	32.768 kHz	CFS-20632768EZBB	\$0.46	1	\$0.46
Voltage Regulator	3V3 LDO	AZ1117EH-3.3TRG1	\$0.43	1	\$0.43
Angled Male Header	6 Pin	M20-9960645	\$0.35	1	\$0.35
IC Socket	28 DIP	A 28-LC-TT	\$0.34	1	\$0.34
DIP Socket	16 DIP	A 16-LC-TT	\$0.25	1	\$0.25
IC Socket	14 DIP	A 14-LC-TT	\$0.22	1	\$0.22
Mom. Button	SPST	1825910-7	\$0.11	2	\$0.22
IC Socket	8 DIP	A 8-LC-TT	\$0.18	1	\$0.18
<b>Total</b>					<b>\$32.26</b>

*Figure 3. Bill of Materials*



## **Problems Encountered**

### Wireless Communication

It would have been ideal to have a Bluetooth or Wifi module to interface via a serial port but it conflicted with the need to have all through hole components that students could easily solder by hand with little to no soldering experience.

### Voltage Regulator

An economic low voltage dropout regulator could not be found in a suitable through hole format so a large format surface mounted device was chosen.

### Boardhouse Limitations

Most low-volume board houses for printed circuit board manufacture limit board size to 10 cm by 10 cm. This conflicted with early designs that had integrated sensors on board as well as a breadboard for easy prototyping. This limitation was eventually overcome when the size of the board shifted to a 2.2" square with 1" square modules.

### PICkit3 Power Limitations

The Felix board cannot have every sensor port occupied when programming the device at 5V or 3.3V. The PICkit3 can only provide 200 mA of current to the board during programming and this limit can be exceeded especially when LED arrays are in use as each LED consumes a large amount of current despite a large current limiting resistor.

### Four Digit Seven Segment Display Brightness

When current limiting resistors were used with the 4x7 segment display, segments appeared too dim during multiplexing. To counter this, no current limiting resistors were used and current limiting now relies on abusing the decoder output driver limitations, which may shorten the life of the integrated circuit.

### Rotary Encoder Noise

The low cost rotary encoders purchased had too much noise on the data lines to be used reliably. By adding a small RC filter to each of the data lines, most of the noise is mitigated.

## **Future Recommendations**

### Increased Complexity with Subassemblies

To increase complexity of the board and lower cost, it is recommended to switch to surface mounted subassemblies. Students could still be required to solder headers and other large components onto the subassemblies, but it would expand the kinds of circuits they could utilize (wireless communications, gyro/accelerometers, etc) while also shrinking the amount of time it takes to put a kit together.

## CONCLUSION

### Annotated Bibliography

[1] Ferris, Timothy (2012) *The 4-Hour Chef: The Simple Path to Cooking Like a Pro, Learning Anything, and Living the Good Life*. Seattle, WA: New Harvest Publishing

Specifically in the “Meta-Learning” section of this text, Ferriss discusses how students learn and points out specific pitfalls to the learning process and how to avoid them. While not every challenge can be mitigated, by considering them at the conception of this project, the end product is more conducive to learning and aims to avoid common learning mistakes. This is especially true of Ferriss’ “DiSSS” breakdown :

- Deconstruction - defining the minimum viable product to be successful
- Selection - Find the 20% of actions that will result in 80% of successes
- Sequencing - Prioritize and plan what to learn and how
- Stakes - Create consequences for not following the plan that hold personal value

[2] Hunt, Andy (2008) *Pragmatic Thinking and Learning: Refactor Your Wetware*. Raleigh, NC: The Pragmatic Bookshelf

The Dreyfus model of learning states that, when learning a new subject, there are five stages of thought development all people exhibit:

1. Novice – needs exact instructions
2. Advanced Beginners – can work on their own, has difficulty troubleshooting/diagnosing
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Ideally, students would go from novice to expert in the span of three months, but that is just too much to ask of any individual. It would be considered a resounding success to get all students from novice to competent. With enough information, students can then make informed decisions to continue their studies in embedded systems or pursue other paths.

[3] Microchip (2012-2018) *PIC18F25K40*. Chandler, AZ: Microchip Technologies, Inc.  
Retrieved from: <https://www.microchip.com/wwwproducts/en/PIC18F24K40>

This document was used as a reference for planning out hardware interactions, potential sensors, and determining the placement of components on the circuit board. It also allowed for the determination of capabilities to validate in the device.

[4] Microchip (2012-2018) *MCP 7940M: Low-Cost I<sup>2</sup>C Real-Time Clock/Calendar with SRAM*  
Chandler, AZ: Microchip Technologies, Inc.

Retrieved from: <https://www.microchip.com/wwwproducts/en/MCP7940M>

This document provided technical specifications and most importantly memory register maps (see Appendix C) for use in interfacing and validating with the real time clock module.

# APPENDIX A: Supporting Documents

### problem

- effects students in EECE 4038C and ELTN 4083C
- students have to purchase expensive equipment
- lacks computational power
- limits educational goals
- little/no use beyond course

**BASIC Stamp HomeWork (Left)**  
16 I/O, No ADC, 1 MHz (\$27.99)

**(right) Microchip Curiosity**  
18 I/O, 10 ADC Pins, 8 MHz (\$40.00)

Elegoo 31 Sensor Kit (\$19.99)

previous total cost **\$89.98**

### solution

- low-cost development kit
- through hole components (solderable by amateurs)
- "plug and play" modules
- focus on UI/UX

### capabilities

- 24 I/O Pins
- 3 8-bit Ports (A,B,C)
- All pins ADC capable
- Human readable format
- Max Clock 64 MHz
- Low Power Sleep
- Serial to USB Bridge
- Serial, I2C, SPI Hardware
- Pulse Width Modulation
- 30 Level Stack
- 3 Interrupts
- 256 Bytes EEPROM

## felix: a better embedded system development kit

### process

- 1 Determine skills to teach
- 2 Decide on components
- 3 Paper craft the layout
- 4 Iterate on designs
- 5 Prototype designs
- 6 Validate internally
- 7 Test with students
- 8 Integrate into classes

### final design

- felix controller (top, left)
- potentiometer
- basic I/O
- rotary encoder (top, right)
- Precision real time clock (bottom, right)
- 4x 7 segment display (bottom, left)
- prototyping module
- full port readout

### conclusion

- successfully built by 4 students
- used for two EECE 4038C final projects
- ~\$35.00 final price (only goes down with economies of scale)

### standards

- RoHS Compliant
- IPC-A-610, *Acceptability of Electronic Assemblies*
- UMI0204, *I2C-Bus*
- RS232, *Serial Bus*

### team CE 28

**Ryan M. Norton**  
 BS Electrical Engineering

**Dr. Carla Purdy**  
 Project Advisor

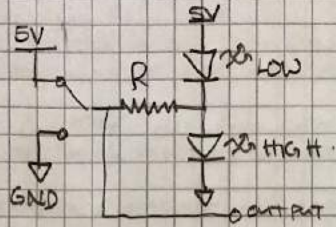
**Jason "J" Heyl**  
 Technical Advisor

### bill of materials

Part	Value	#	\$
Display	4x7 Segment	1	\$3.96
Female Header	6 Pin	7	\$3.64
Resistors	1k, Small	30	\$3.00
UART USB Bridge	MCP 2221	1	\$2.60
Smoothing Caps	0.1uF	7	\$2.03
Male Header	6 Pin	8	\$2.00
LEDs	Green	12	\$1.92
USB Port	MiniB	1	\$1.64
LEDs	Red	9	\$1.62
Microcontroller	PI/C18T2K40	1	\$1.52
Rotary Encoder	EN11-HSM1A/F15	1	\$1.25
Switch	2PDT	2	\$1.08
Real Time Clock	MCP 79A0M	1	\$0.66
Potentiometer	10K	1	\$0.63
Oscillator Caps	15 pF	2	\$0.62
Decoder	3x8 Active Low	1	\$0.60
Buzzer	WT-1205	1	\$0.54
Boards	Assorted	1	\$0.50
Crystal Oscillator	32.768 KHz	1	\$0.46
Voltage Regulator	3V3 LDO	1	\$0.43
90° Male Header	6 Pin	1	\$0.35
IC Socket	28 DIP	1	\$0.34
DIP Socket	16 DIP	1	\$0.25
IC Socket	14 DIP	1	\$0.22
Morn. Button	SPST	2	\$0.22
IC Socket	8 DIP	1	\$0.18
open source hardware			Total \$32.36
Compared to \$89.98			Savings of \$57.62

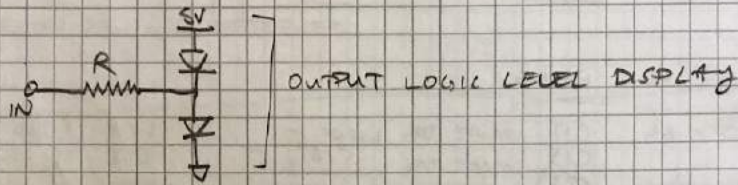
University of CINCINNATI

happy nerd company

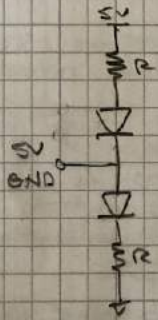


DOES IT NEED A BUFFER FOR INPUT/OUTPUT?

PROBABLY NOT SINCE IT WILL BE CONNECTED DIRECTLY TO +V/GND.

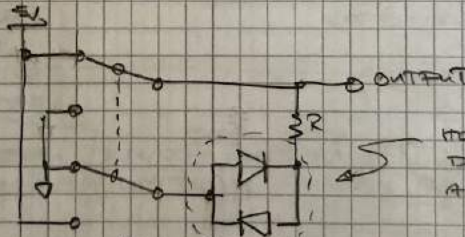


NOT THIS WAY WORK AND YOUR DUMB, DUMB. THE TWO LEDS ALREADY HAVE VOLTAGE ACROSS THEM.



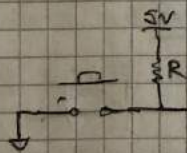
THIS MIGHT WORK BUT BOTH LEDS WILL LIGHT WHEN NOT FLOATING, BUT DIMMER!

USE DPDT SWITCHES!



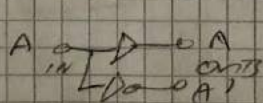
HOW COULD YOU DO THIS W/ A PUSH BUTTON?

EFFECTUALLY AN HALF BRIDGE.



WOULD NOT BE SPECIALLY EFFECTIVE.

IS THERE ANY IC THAT DOES THIS?



COULD WE JUST USE PARALLEL MEMOR-1?

FEEDBACK DEVICE

3 BUTTONS ON THE FRONT  
LED INDICATOR FOR LOW BATTERY

ADC FOR BATTERY  
VOLTAGE

41 BUTTON ON THE BACK  
9 SEGMENT DISPLAY ON BACK.

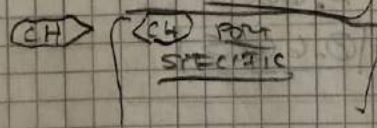
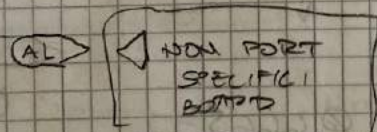
BUZZER/ BEEP IC  
PS 6122XX

EEPROM (OPTIONAL ONBOARD OR OTHERWISE)  
RUNS ON AA BATTERIES.

PID EXAMPLE ROTARY ENCODER / POTENTIOMETER  
ON A SLEDGE HAMMER YOU CAN SLIDE HAMMER  
BACK/FORTH + BELT DRIVE. LIMIT SWITCHES  
AT EITHER END + POSSIBLE ENCODER TO DETERMINE  
POSITION.

TRY ~ BALANCE IT YOU COULD EVEN ADD A PORTABLE  
ENCODER MODULE TO TRY TO LET PEOPLE MANUALLY BALANCE IT.

-> HAVE A SERIAL INTERFACE + GRAPH THE OUTPUT!



DEMO IDEAS  
FFT. W/ LED MATRIX READOUT

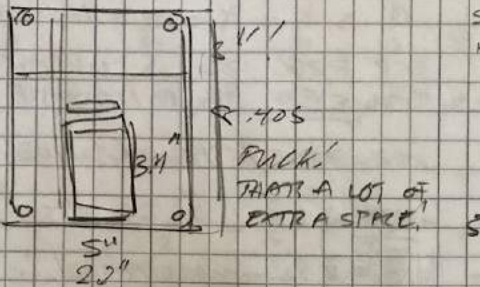
I WANT A PICKIT HOLDER w/ OSCILLOSCOPE  
ATTACHMENTS OR SOME SUPERFAST IC PULLING  
DATA FROM THE 40 PIN HEADER + SHOWING REAL TIME  
DATA ON BOARD. MAKE ITS A PIC16F1640 AT 64MHZ  
AND THE HIGHEST YOU CAN DEBK AT IS LIKE 5MHz. ... 10K.

ARE SQUARE MODULES OKAY?

BREADBOARD SHOULD BE CENTERED.  
CONSIDER GOING METRIC. → WOT 5" SQUARE

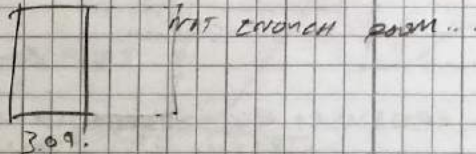
5"  $\cdot$  2.54 = 10 + 2.5 ~ 12.5 15cm SQUARE? TOO BIG?

WHT DO YOU WANT A SQUARE... GO GOLDEN!



SHIFT THE BREADBOARD TO HALF OF IT!

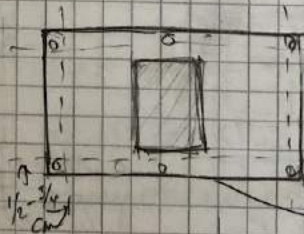
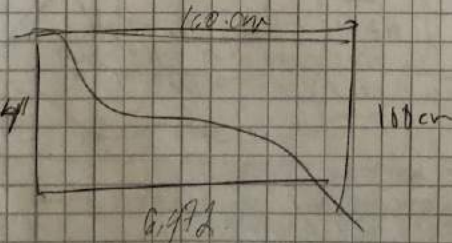
OKAY LETT MAKE 5" THE LONG SIDE.



WOULD YOU CONSIDER A SMALLER BREADBOARD? (PICK 1)

YES  BUT I DONT WANT TO  NO ... OR WELL

LET START W/ THE BREADBOARD AS A DIMENSIONER...

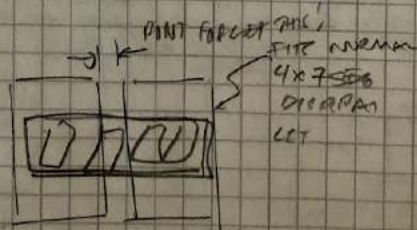


START FROM THE BOTTOM... HOW BIG DO MODULES NEED TO BE?

TWO CRITERIA.



BRUNNEN



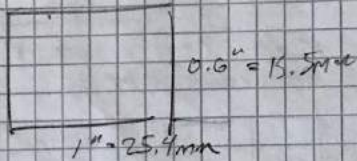
HOLD SHIT PROBABLY THE ALARM W/ TRANSIT

- PHASE CONTROL (1)
- MODALE (2)
- 4x9 SEG (1)
- BT (1)
- RS ENCODER (1)

QUESTIONS  
 DIMENSIONS OF 469 SEG DISPLAY?  
 DIM OF ESP8266 I2C?  
 DIM OF SOME BLUETOOTH UART

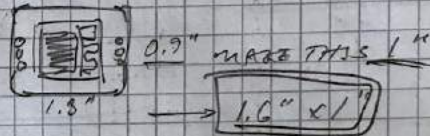
$\frac{3mm}{24mm} \times 16mm$   
 $\times$

→ SHOULD JUST USE BLE MODULE THAT FITS IT W/ I2C?  
 YES  NO PROGRAM I2C  
 → BUT THE ECOSYSTEM!



ESP 8266 I2C IS CURRENTLY THE SIZE OF A MODULE.

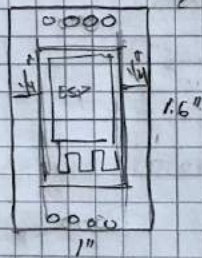
ADD 300m to each dimension.



WHY DO I FEEL THE NEED TO CREATE AN ECOSYSTEM?

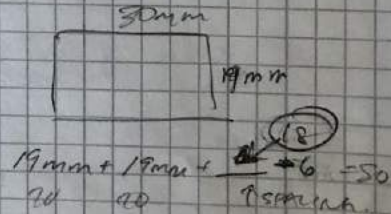
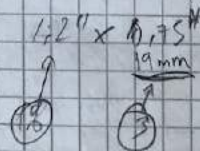
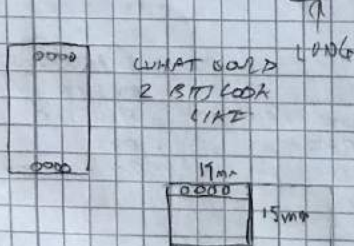
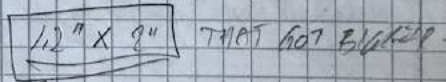
"PARALLELEGRAM" "L-GANT" E/GANT SQUARE

THIS LOOKS BURR



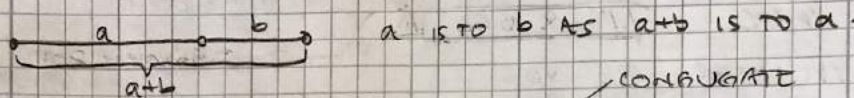
MARK SHOWS SO YOU CAN EXACTLY STEP OUT 1 FT EACH TIME!

100mils MORE ON EACH SIDE.



100mils = 7.94 = 8mm

### THE GOLDEN RATIO



$$\frac{a}{b} = \frac{a+b}{a} = \varphi \text{ (GOLDEN RATIO)} = \varphi, \phi \text{ (CONJUGATE (DEPENDENT ON WHO'S ASKING))}$$

$$\frac{a+b}{a} = 1 + \frac{b}{a} = \varphi = \frac{a}{b} \therefore \frac{b}{a} = \frac{1}{\varphi} \therefore 1 + \frac{1}{\varphi} = \varphi$$

$$\rightarrow \varphi + 1 = \varphi^2 \therefore \varphi^2 - \varphi - 1 = 0$$

BY QUADRATIC FORMULA

$$\varphi = \frac{1 \pm \sqrt{5}}{2} = \left\{ 1.61803..., -0.61803... \right\}$$

$$\phi = 0.618$$

$$\phi = \varphi - 1$$

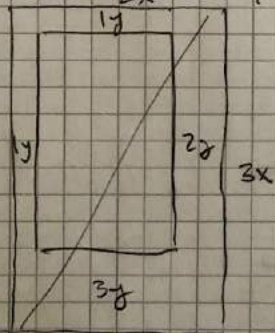
IN A PREMATURE ATTEMPT TO AVOID NEGATIVE NUMBERS THE GOLDEN RATIO WAS DECLARED  $\varphi = 1.618$

→ THE VETROVIAN MAN ONLY USES WHOLE # RATIOS

BOOK DESIGN  
2X

1:1.2:3 MARGINS  
2:1.5 PAGES

1:√3 OLD AS WELL



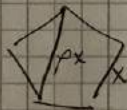
ADOLF ZUSING - PATTERNS IN NATURE

→ CALLED GOLDEN RATIO A "UNIVERSAL LAW"

$$\frac{1}{\varphi} = \varphi - 1 ; \frac{1}{\phi} = \phi + 1$$

$$\phi : 1 = 1 : \varphi$$

→ TURNS UP IN PENTAGONAL SYMMETRY



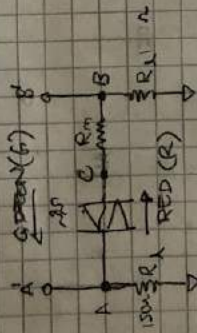
COMES INTO PLAY w/ TITMANN PROBLEM OF EVENLY DISTRIBUTING POINTS ON A SPHERE  
→ DIVIDE SPHERE INTO LATITUDES CONTAINING EQUAL SURFACE AREA + ONE NODE ON EACH BAND AT A GOLDEN RATIO OFFSET OF ANOTHER  
 $360^\circ \varphi = 222.5^\circ$

WITH THIS CONFIG  
YOU COULD PLAY  
SIMON SAYS, HAHA!

A1 A2  
A OPTIONS DRIVEN TO VCC  
FLOATING

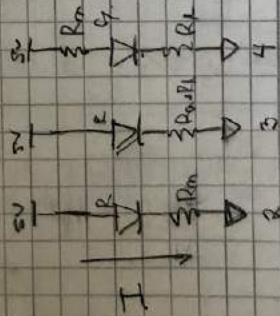
B1 B2  
B' OPTIONS DRIVEN TO VCC  
DRIVEN TO GND  
FLOATING.

X' → DENOTES CONTROL



CONTROL	VOLTAGE	LED	RS	COMMENTS
1 A1 B1	A 5 B 5 C 5	OFF	0	
2 A1 B2	A 5 B 0 C 2.5	R	1	BRIGHTER
3 A1 B3	A 5 B 2.5 C 1.25	R	2	WORRIED THAT THE VOLTAGE WON'T BE HIGH ENOUGH.
4 A2 B1	A 2.5 B 5 C 3.75	G	2	
5 A2 B2	A 0 B 0 C 0	OFF		
6 A2 B3	A 0 B 0 C 0	OFF		

LED CONFIGURATIONS



ELECTRICALLY  
EQUIVALENT AT  
LOW SPEEDS

$R_{min} = 220$  MAKE ALL 220?  
 $R_{max} = 440$ ?

LOGIC HIGH: 2-5V  
LOGIC LOW: 0-0.8V

ILLEGAL: 0.8-2V

NO 3D PRINT / LASER CUTS!



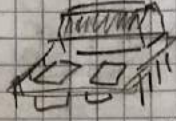
ROTARY ENCODER (1/2)



USB-SERIAL CONVERTER (1/2)



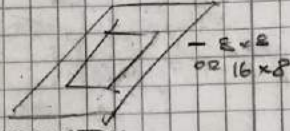
4x7 SEG. DISPLAY (1)



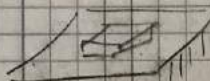
2x SOLID STATE RELAY (1/2)



RTC MODULE (1/2)  
TRC



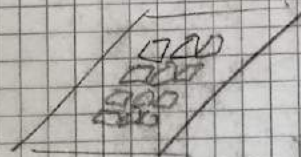
LED MATRIX DISPLAY  
- 8x8 OR 16x8



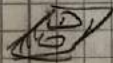
ANDR0U 3-AXIS ACCELEROMETER w/ ENABLE



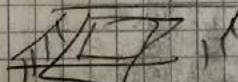
JOYSTICK SENSOR (1/2)



MATRIX BUTTON INPUT (1)



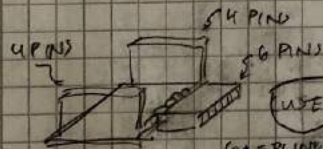
2 SWITCHES (1/4)



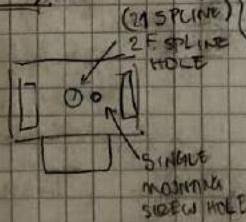
ESP8266 WIFL BOARD (1)



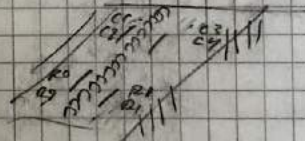
BLE BOARD (1/2)



(USE JUMPERS TO CONNECT)

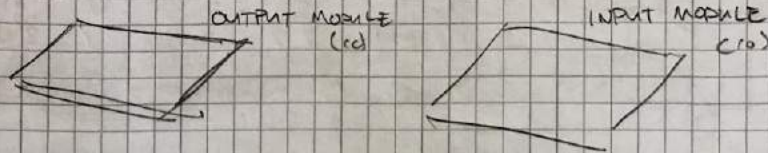


(2x SPINE)  
2x SPINE HOLE  
SINGLE MOUNTING SIDE HOLE



LED 16 PIN (1)  
GNDH

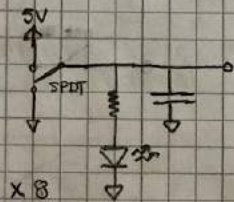
EACH STUDENT GETS ONE (2?) SO GROUPS HAVE MULTIPLES!



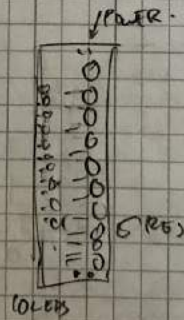
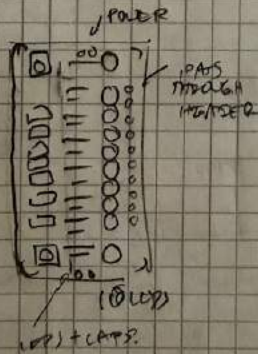
DO WE USE LED ARRAYS OR INDIVIDUAL LEDS FOR THE OUTPUT

BIDIRECTIONAL WOULD BE NICE BUT IND. IS PROBABLY CHEAPER + FINE FOR DIGITAL WORK

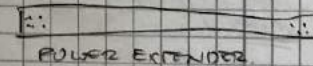
OUTPUT



x 2 w/ TACTILE SWITCH (LOCKS) (RESETS)



PCW



x 2

31 mm<sup>2</sup>  
 $3.2 \cdot 10^{-5} \text{ m}^2$

$$P_1 + \frac{1}{2} \rho v^2 = P_2 + \frac{1}{2} \rho v^2$$

const

$$P_1 + \frac{1}{2} \rho v^2 = P_2 + \frac{1}{2} \rho v^2$$

$$\Delta P = \frac{1}{2} \rho (v_2^2 - v_1^2)$$

$$\sqrt{\frac{2 \Delta P}{\rho}} = v$$



THERMISTOR  
(TEMPERATURE)

SWITCH  
MODULE

USB TO SERIAL  
CONVERTER

ROTARY  
ENCODER

SERIAL BLE  
COMMUNICATION

PHOTORESISTOR  
MATRIX

ACCEL/GYRO  
IIC SENSOR

SERVO MOTOR  
EXTENDER/MOUNT

LED ARRAY  
REGISTER RESISTOR

MULTIPLEXED  
4x7 SEG. DISPLAY

PIEZOELECTRIC  
BUZZER

CAPACITIVE TOUCH  
SENSOR

IPC PCB W/  
COINCELL

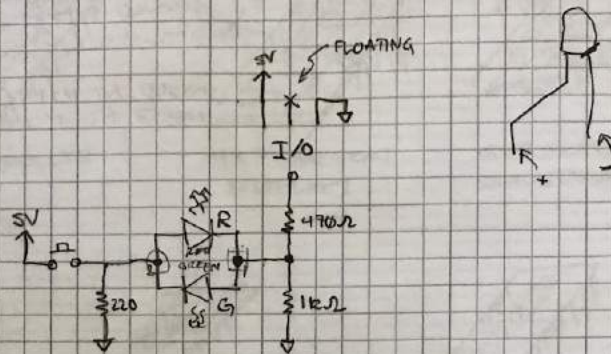
DUAL PHASE  
CONTROLLER

LED MATRIX  
DISPLAY

EXTERNAL  
EEPROM?

DIMENSIONS	HEIGHT		WIDTH	
	MILS	MM	MILS	MM
FULL	1650	~41	1200	~31
HALF	750	~20	1200	~31
QUARTER	750	~20	50	~13

USE "MOUSE BITES"  
TO PUT ALL BOARDS ON  
ONE  
4 1/2" x 3" =



	BUTTON STATE	I/O STATE	LEDS ON	I/O (V)	(KTI (mA))
1	PRESSED	HIGH	NONE	4.925	26
2	NOT	HIGH	GREEN	4.983	5
3	PRESSED	LOW	RED (BRIGHT)	0.016	32
4	NOT	LOW	NONE	0.000	0
5	PRESSED	INPUT	RED	3.040	26
6	NOT	INPUT	NONE	0.000	0

IN STATES 1,3,5 23mA GO THROUGH 220Ω RESISTOR

IN 1... 3mA TO 470+1kΩ RESISTORS

IN 5... 3mA TO RED LED

IN 3... 9mA TO RED LED

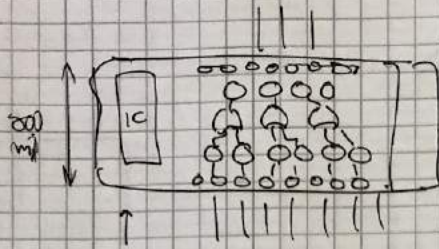
IN 2... ALL 5mA GOES THROUGH THE GREEN LED.

#### RESULTS:

THIS WILL WORK. THE VOLTAGE WHEN INPUT ON HIGH IS WELL ABOVE THE 2V THRESHOLD.

RED TRIPLE CURRENT IS NOT VISIBLY DISTINGUISHABLE FROM SINGLE CURRENT W/O SIDE BY SIDE COMPARISON.

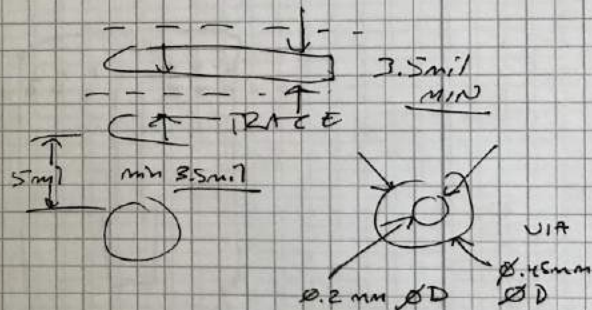
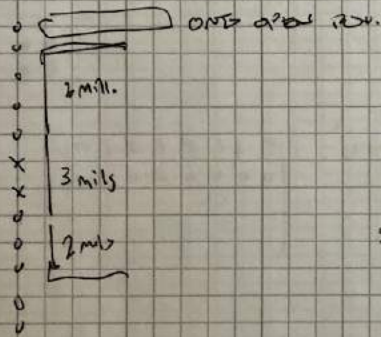
HOWEVER THE CURRENTS ARE SUCH THAT NO COMPONENTS WILL BE DAMAGED AND ONLY 33mA ARE SOURCED FROM THE MICROCONTROLLER PIN OF THE TOTAL 26mA CONSUMED.



302 CHIP  
THAT SHOWS LOGIC  
LEVELS.

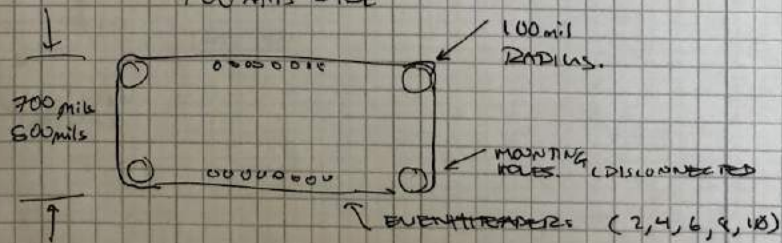
WOULD BE COOL IF YOU COULD HAVE A FEW  
OF THESE. THEN YOUR OUTPUTS ARE ALWAYS  
FINAL ;)

MOST THINGS SHOULD  
BE 700 mils wide



DESIGN RULES...

700 mils wide



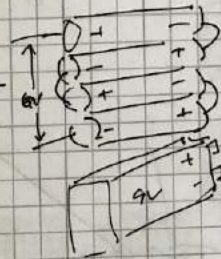
### POWER SUPPLY

NEED TO OPERATE AT 3V/5V (SWITCHABLE)  
NEEDS ON/OFF SWITCH  
RUNS ON AA BATTERIES OR USB POWER OR 9V DC JACK

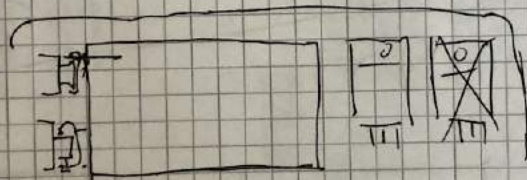
### AA BATTERY VOLTAGE OVER TIME



MUST BE AT A MINIMUM OF



DO A LINEAR REGULATOR w/ 9V, DC JACK + BATTERY.



9V 300

APPENDIX B: Design Files

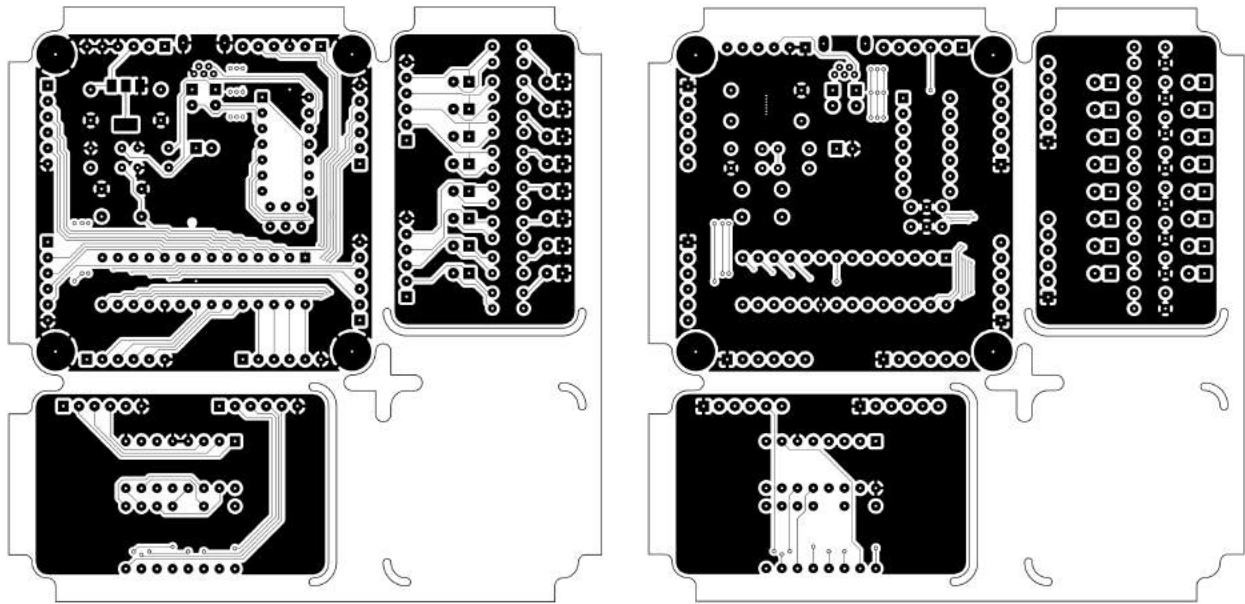


Figure 5. Panel A Front and Back  
(Felix Controller, 4x7 Segment Display, LED Array)

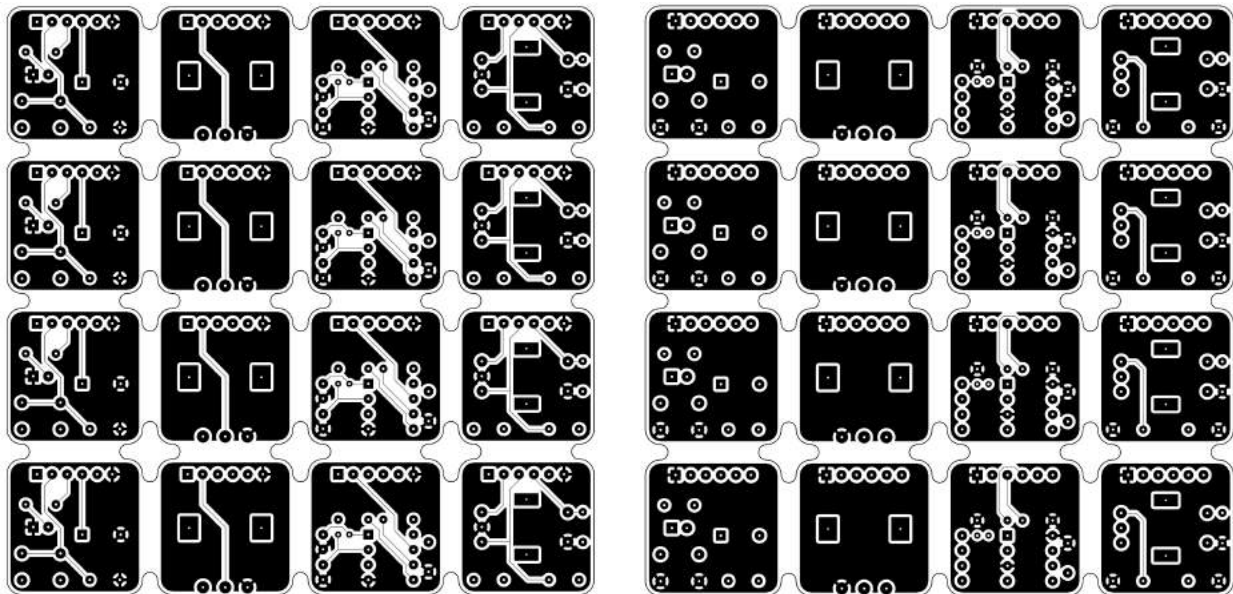
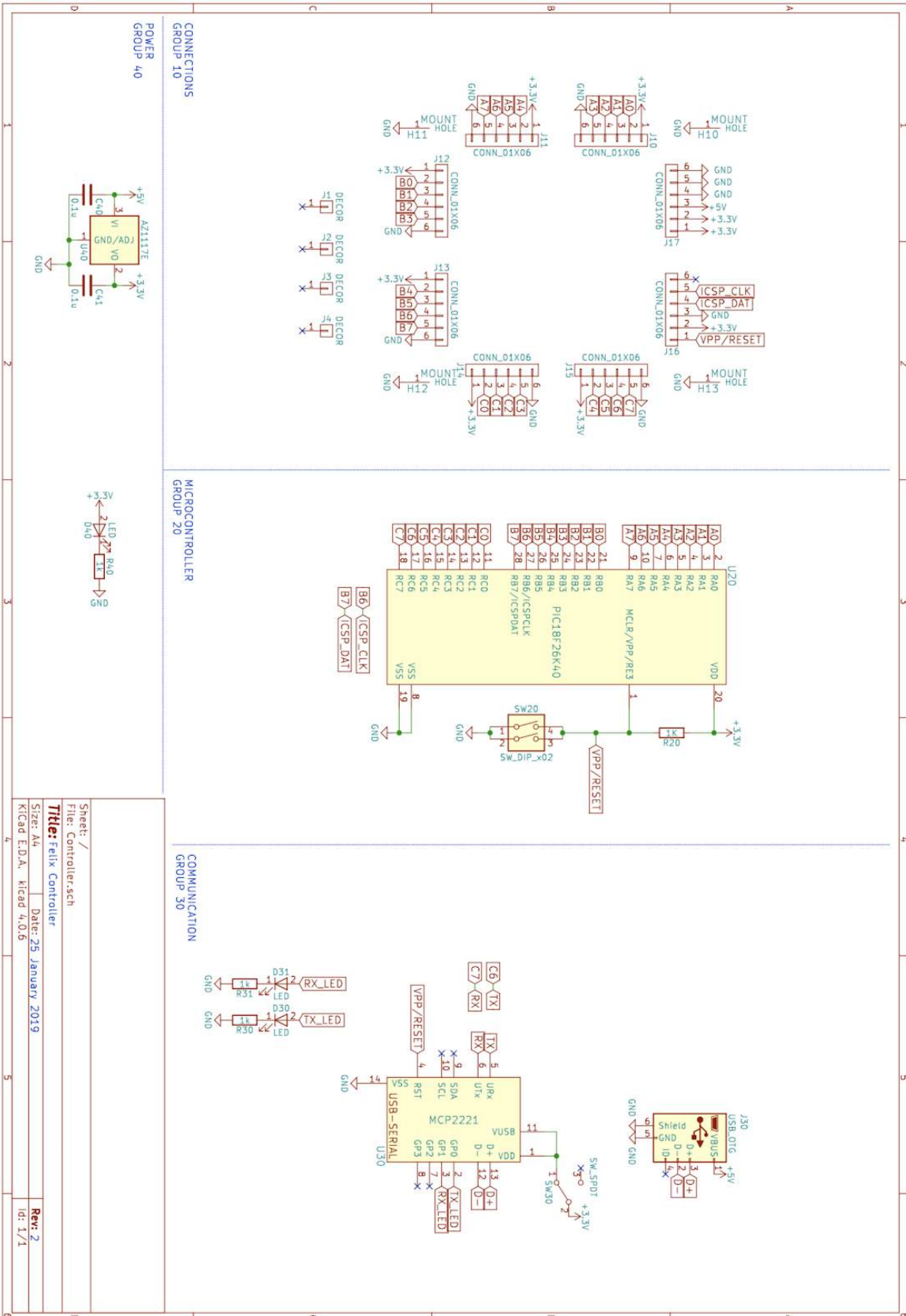


Figure 6. Panel B Front and Back  
(GPIO Array, Potentiometer, Real Time Clock, Rotary Encoder)



Sheet: /  
 File: Controller.sch  
**Title:** Felix Controller  
 Size: A4 Date: 25 January 2019  
 Kicad E.D.A. kicad 4.0.6  
 Rev: 2  
 Id: 1/1

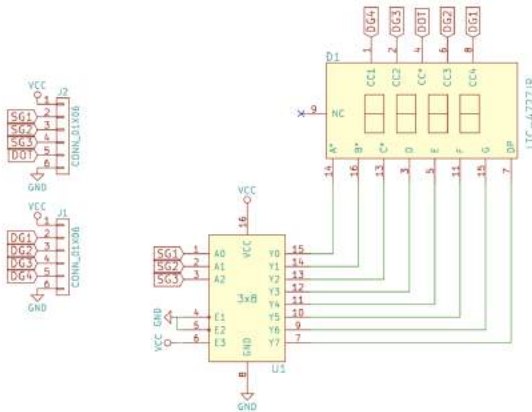


Figure 7. 4x7 Segment Display

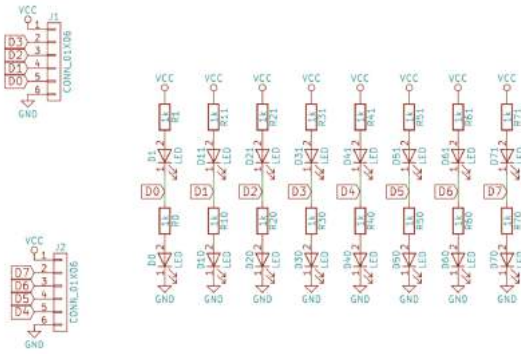


Figure 8. LED Array

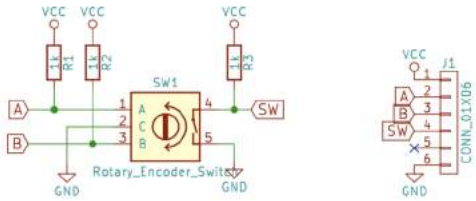


Figure 9. Rotary Encoder

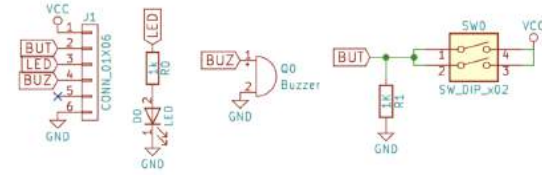


Figure 10. GPIO Array



Figure 11. Potentiometer

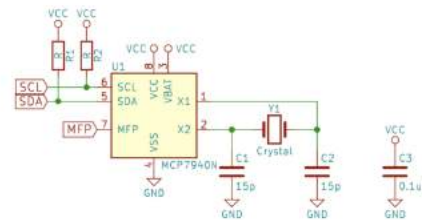


Figure 12. Real Time Clock

## APPENDIX C: Datasheets



## PIC18(L)F24/25K40

### 28-Pin, Low-Power, High-Performance Microcontrollers with XLP Technology

#### Description

These PIC18(L)F24/25K40 microcontrollers feature Analog, Core Independent Peripherals and Communication Peripherals, combined with eXtreme Low-Power (XLP) technology for a wide range of general purpose and low-power applications. These 28 -pin devices are equipped with a 10-bit ADC with Computation (ADCC) automating Capacitive Voltage Divider (CVD) techniques for advanced touch sensing, averaging, filtering, oversampling and performing automatic threshold comparisons. They also offer a set of Core Independent Peripherals such as Complementary Waveform Generator (CWG), Windowed Watchdog Timer (WWDT), Cyclic Redundancy Check (CRC)/Memory Scan, Zero-Cross Detect (ZCD) and Peripheral Pin Select (PPS), providing for increased design flexibility and lower system cost.

#### Core Features

- C Compiler Optimized RISC Architecture
- Operating Speed:
  - DC – 64 MHz clock input over the full  $V_{DD}$  range
  - 62.5 ns minimum instruction cycle
- Programmable 2-Level Interrupt Priority
- 31-Level Deep Hardware Stack
- Three 8-Bit Timers (TMR2/4/6) with Hardware Limit Timer (HLT)
- Four 16-Bit Timers (TMR0/1/3/5)
- Low-Current Power-on Reset (POR)
- Power-up Timer (PWRT)
- Brown-out Reset (BOR)
- Low-Power BOR (LPBOR) Option
- Windowed Watchdog Timer (WWDT):
  - Watchdog Reset on too long or too short interval between watchdog clear events
  - Variable prescaler selection
  - Variable window size selection
  - All sources configurable in hardware or software

#### Memory

- Up to 32K bytes Program Flash Memory
- Up to 2048 Bytes Data SRAM Memory

## PIC18(L)F24/25K40

---

- 256 Bytes Data EEPROM
- Programmable Code Protection
- Direct, Indirect and Relative Addressing modes

### Operating Characteristics

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- Operating Voltage Ranges:
  - 1.8V to 3.6V (PIC18LF24/25K40 )
  - 2.3V to 5.5V ( PIC18F24/25K40)
- Temperature Range:
  - Industrial: -40°C to 85°C
  - Extended: -40°C to 125°C

### Power-Saving Operation Modes

---

- Doze: CPU and Peripherals Running at Different Cycle Rates (typically CPU is lower)
- Idle: CPU Halted While Peripherals Operate
- Sleep: Lowest Power Consumption
- Peripheral Module Disable (PMD):
  - Ability to selectively disable hardware module to minimize active power consumption of unused peripherals
- Extreme Low-Power mode (XLP)
  - Sleep: 500 nA typical @ 1.8V
  - Sleep and Watchdog Timer: 900 nA typical @ 1.8V

### eXtreme Low-Power (XLP) Features

---

- Sleep mode: 50 nA @ 1.8V, typical
- Windowed Watchdog Timer: 500 nA @ 1.8V, typical
- Secondary Oscillator: 500 nA @ 32 kHz
- Operating Current:
  - 8 uA @ 32 kHz, 1.8V, typical
  - 32 uA/MHz @ 1.8V, typical

### Digital Peripherals

---

- Complementary Waveform Generator (CWG):
  - Rising and falling edge dead-band control
  - Full-bridge, half-bridge, 1-channel drive
  - Multiple signal sources
- Capture/Compare/PWM (CCP) modules:
  - Two CCPs
  - 16-bit resolution for Capture/Compare modes
  - 10-bit resolution for PWM mode
- 10-Bit Pulse-Width Modulators (PWM):

## PIC18(L)F24/25K40

---

- Two 10-bit PWMs
- Serial Communications:
  - One Enhanced USART (EUSART) with Auto-Baud Detect, Auto-wake-up on Start, RS-232, RS-485, LIN compatible
  - SPI
  - I<sup>2</sup>C, SMBus and PMBus™ compatible
- Up to 25 I/O Pins and One Input Pin:
  - Individually programmable pull-ups
  - Slew rate control
  - Interrupt-on-change on all pins
  - Input level selection control
- Programmable CRC with Memory Scan:
  - Reliable data/program memory monitoring for Fail-Safe operation (e.g., Class B)
  - Calculate CRC over any portion of Flash or EEPROM
  - High-speed or background operation
- Hardware Limit Timer (TMR2/4/6+HLT):
  - Hardware monitoring and Fault detection
- Peripheral Pin Select (PPS):
  - Enables pin mapping of digital I/O
- Data Signal Modulator (DSM)

### Analog Peripherals

---

- 10-Bit Analog-to-Digital Converter with Computation (ADC<sup>2</sup>):
  - 24 external channels
  - Conversion available during Sleep
  - Four internal analog channels
  - Internal and external trigger options
  - Automated math functions on input signals:
    - Averaging, filter calculations, oversampling and threshold comparison
  - 8-bit hardware acquisition timer
- Hardware Capacitive Voltage Divider (CVD) Support:
  - 8-bit precharge timer
  - Adjustable sample and hold capacitor array
  - Guard ring digital output drive
- Zero-Cross Detect (ZCD):
  - Detect when AC signal on pin crosses ground
- 5-Bit Digital-to-Analog Converter (DAC):
  - Output available externally
  - Programmable 5-bit voltage (% of  $V_{DD}$ ,  $[V_{Ref+} - V_{Ref-}]$ , FVR)
  - Internal connections to Comparators and ADC
- Two Comparators (CMP):
  - Four external inputs
  - External output via PPS

## PIC18(L)F24/25K40

- Fixed Voltage Reference (FVR) module:
  - 1.024V, 2.048V and 4.096V output levels
  - Two buffered outputs: One for DAC/CMP and one for ADC

### Clocking Structure

- High-Precision Internal Oscillator Block (HFINTOSC):
  - Selectable frequencies up to 64 MHz
  - $\pm 1\%$  at calibration
- 32 kHz Low-Power Internal Oscillator (LFINTOSC)
- External 32 kHz Crystal Oscillator (SOSC)
- External High-frequency Oscillator Block:
  - Three crystal/resonator modes
  - Digital Clock Input mode
  - 4x PLL with external sources
- Fail-Safe Clock Monitor:
  - Allows for safe shutdown if external clock stops
- Oscillator Start-up Timer (OST)

### Programming/Debug Features

- In-Circuit Serial Programming™ (ICSP™) via Two Pins
- In-Circuit Debug (ICD) with Three Breakpoints via Two Pins
- Debug Integrated On-Chip

### PIC18(L)F24/25K40 Family Types

Table 1. Devices included in this data sheet

Device	Program Memory Flash (bytes)	Data SRAM (bytes)	Data EEPROM (bytes)	I/O Pins	16-bit Timers	Comparators	10-bit ADC <sup>2</sup> with Computation (ch)	5-bit DAC	Zero-Cross Detect	CCP/10-bit PWM	CWG	SMT	Low Voltage Detect (LVD)	8-bit TMR with HLT	Windowed Watchdog Timer	CRC with Memory Scan	EUSART	I <sup>2</sup> C/SPI	PPS	Peripheral Module Disable	Temperature Indicator	Debug(I)
PIC18(L)F24K40	16k	1024	256	25	4	2	24	1	1	2/2	1	0	1	3	Y	Y	1	1	Y	Y	Y	I
PIC18(L)F25K40	32k	2048	256	25	4	2	24	1	1	2/2	1	0	1	3	Y	Y	1	1	Y	Y	Y	I

## PIC18(L)F24/25K40

**Table 2. Devices not included in this data sheet**

Device	Program Memory Flash (bytes)	Data SRAM (bytes)	Data EEPROM (bytes)	I/O Pins	16-bit Timers	Comparators	10-bit ADC <sup>2</sup> with Computation (ch)	5-bit DAC	Zero-Cross Detect	CCP/10-bit PWM	CWG	SMT	Low Voltage Detect (LVD)	8-bit TMR with HLT	Windowed Watchdog Timer	CRC with Memory Scan	EUSART	I <sup>2</sup> C/SPI	PPS	Peripheral Module Disable	Temperature Indicator	Debug <sup>(1)</sup>
PIC18(L)F26K40	64k	3615	1024	25	4	2	24	1	1	2/2	1	0	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F27K40	128k	3615	1024	25	4	2	24	1	1	2/2	1	0	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F45K40	32k	2048	256	36	4	2	35	1	1	2/2	1	0	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F46K40	64k	3615	1024	36	4	2	35	1	1	2/2	1	0	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F47K40	128k	3615	1024	36	4	2	35	1	1	2/2	1	0	1	3	Y	Y	2	2	Y	Y	Y	I
PIC18(L)F65K40	32k	2048	1024	60	5	3	45	1	1	5/2	1	2	1	4	Y	Y	5	2	Y	Y	Y	I
PIC18(L)F66K40	64k	3562	1024	60	5	3	45	1	1	5/2	1	2	1	4	Y	Y	5	2	Y	Y	Y	I
PIC18(L)F67K40	128k	3562	1024	60	5	3	47	1	1	5/2	1	2	1	4	Y	Y	5	2	Y	Y	Y	I

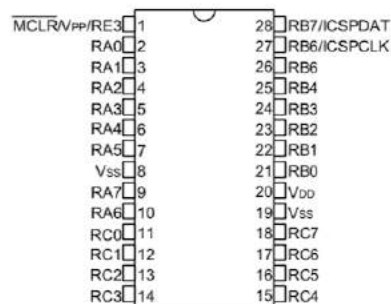
**Note:** Debugging Methods: (I) – Integrated on Chip.

Data Sheet Index:

1. [DS40001843 PIC18\(L\)F24/25K40 Data Sheet, 28-Pin, 8-bit Flash Microcontrollers](#)
2. [DS40001816 PIC18\(L\)F26/45/46K40 Data Sheet, 28/40/44-Pin, 8-bit Flash Microcontrollers](#)
3. [DS40001844 PIC18\(L\)F27/47K40 Data Sheet, 28/40/44-Pin, 8-bit Flash Microcontrollers](#)
4. [DS40001842 PIC18\(L\)F65/66K40 Data Sheet, 64-Pin, 8-bit Flash Microcontrollers](#)
5. [DS40001841 PIC18\(L\)F67K40 Data Sheet, 64-Pin, 8-bit Flash Microcontrollers](#)

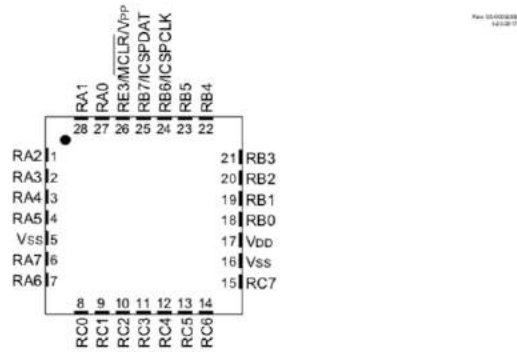
## Pin Diagrams

**Figure 1. 28-pin SPDIP, SSOP, SOIC**



## PIC18(L)F24/25K40

Figure 2. 28-pin QFN, UQFN



**Note:** It is recommended that the exposed bottom pad be connected to  $V_{SS}$ , however it must not be the only  $V_{SS}$  connection to the device.

### Pin Allocation Tables

Table 1. 28-Pin Allocation Table

I/O <sup>(2)</sup>	28-Pin SPDIP, SOIC, SSOP	28-Pin (U)QFN	A/D	Reference	Comparator	Timers	CCP	CWG	ZCD	Interrupt	EUSART	DSM	MSSP	Pull- up	Basic
RA0	2	27	ANA0	—	C1IN0- C2IN0-	—	—	—	—	IOCA0	—	—	—	Y	—
RA1	3	28	ANA1	—	C1IN1- C2IN1-	—	—	—	—	IOCA1	—	—	—	Y	—
RA2	4	1	ANA2	DAC1OUT1 Vref- (DAC) Vref- (ADC)	C1IN0+ C2IN0+	—	—	—	—	IOCA2	—	—	—	Y	—
RA3	5	2	ANA3	Vref+ (DAC) Vref+ (ADC)	C1IN1+	—	—	—	—	IOCA3	—	MDCARL <sup>(1)</sup>	—	Y	—
RA4	6	3	ANA4	—	—	T0CKI <sup>(1)</sup>	—	—	—	IOCA4	—	MDCARH <sup>(1)</sup>	—	Y	—
RA5	7	4	ANA5	—	—	—	—	—	—	IOCA5	—	MDSRC <sup>(1)</sup>	SS1 <sup>(1)</sup>	Y	—
RA6	10	7	ANA6	—	—	—	—	—	—	IOCA6	—	—	—	Y	CLKOUT OSC2
RA7	9	6	ANA7	—	—	—	—	—	—	IOCA7	—	—	—	Y	OSC1 CLKIN
RB0	21	18	ANB0	—	C2IN1+	—	—	CWG1 <sup>(1)</sup>	ZCDIN	IOCB0 INT0 <sup>(1)</sup>	—	—	—	Y	—
RB1	22	19	ANB1	—	C1IN3- C2IN3-	—	—	—	—	IOCB1 INT1 <sup>(1)</sup>	—	—	—	Y	—
RB2	23	20	ANB2	—	—	—	—	—	—	IOCB2 INT2 <sup>(1)</sup>	—	—	—	Y	—

## PIC18(L)F24/25K40

I/O <sup>(2)</sup>	28-Pin SPDIP, SOIC, SSOP	28-Pin (U)QFN	A/D	Reference	Comparator	Timers	CCP	CWG	ZCD	Interrupt	EUSART	DSM	MSSP	Pull- up	Basic
RB3	24	21	ANB3	—	C1IN2- C2IN2-	—	—	—	—	IOCB3	—	—	—	Y	—
RB4	25	22	ANB4	—	—	T5G <sup>(1)</sup>	—	—	—	IOCB4	—	—	—	Y	—
RB5	26	23	ANB5	—	—	T1G <sup>(1)</sup>	—	—	—	IOCB5	—	—	—	Y	—
RB6	27	24	ANB6	—	—	—	—	—	—	IOCB6	—	—	—	Y	ICSPCLK
RB7	28	25	ANB7	DAC1OUT2	—	T6IN <sup>(1)</sup>	—	—	—	IOCB7	—	—	—	Y	ICSPDAT
RC0	11	8	ANC0	—	—	T1CK <sup>(1)</sup> T3CK <sup>(1)</sup> T3G <sup>(1)</sup>	—	—	—	IOCC0	—	—	—	Y	SOSCO
RC1	12	9	ANC1	—	—	—	CCP2 <sup>(1)</sup>	—	—	IOCC1	—	—	—	Y	SOSGIN SOSCI
RC2	13	10	ANC2	—	—	T5CK <sup>(1)</sup>	CCP1 <sup>(1)</sup>	—	—	IOCC2	—	—	—	Y	—
RC3	14	11	ANC3	—	—	T2IN <sup>(1)</sup>	—	—	—	IOCC3	—	—	SCK1 <sup>(1)</sup> SCL1 <sup>(3,4)</sup>	Y	—
RC4	15	12	ANC4	—	—	—	—	—	—	IOCC4	—	—	SDI1 <sup>(1)</sup> SDA1 <sup>(3,4)</sup>	Y	—
RC5	16	13	ANC5	—	—	T4IN <sup>(1)</sup>	—	—	—	IOCC5	—	—	—	Y	—
RC6	17	14	ANC6	—	—	—	—	—	—	IOCC6	CK1 <sup>(1,3)</sup>	—	—	Y	—
RC7	18	15	ANC7	—	—	—	—	—	—	IOCC7	RX1/ DT1 <sup>(1,3)</sup>	—	—	Y	—
RE3	1	26	—	—	—	—	—	—	—	IOCE3	—	—	—	Y	V <sub>pp</sub> /MCLR
VSS	19	16	—	—	—	—	—	—	—	—	—	—	—	—	VSS
VDD	20	17	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	8	5	—	—	—	—	—	—	—	—	—	—	—	—	VSS
OUT <sup>(2)</sup>	—	—	ADGRDA ADGRDB	—	C1OUT C2OUT	TMR0	CCP1 CCP2 PWM3 PWM4	CWG1A CWG1B CWG1C CWG1D	—	—	TX1/ CK1 <sup>(3)</sup> DT1 <sup>(3)</sup>	DSM	SDO1 SCK1	—	—

**Note:**

1. This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to the peripheral input selection table for details on which PORT pins may be used for this signal.
2. All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in the peripheral output selection table.
3. This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.
4. These pins are configured for I<sup>2</sup>C logic levels; The SCLx/SDAx signals may be assigned to any of these pins. PPS assignments to the other pins (e.g., RB1) will operate, but input logic levels will be standard TTL/ST as selected by the INLVL register, instead of the I<sup>2</sup>C specific or SMBus input buffer thresholds.

## PIC18(L)F24/25K40

### Device Configuration

### 3.6 Register Summary - Configuration Words

Offset	Name	Bit Pos.							
0x300000	CONFIG1	7:0		RSTOSC[2:0]			FEXTOSC[2:0]		
		15:8		FCMEN	GSWEN			CLKOUTEN	
0x300002	CONFIG2	7:0		BOREN[1:0]	LPBOREN			PWRTE	MCLRE
		15:8	XINST		DEBUG	STVREN	PPS1WAY	ZCD	BORV[1:0]
0x300004	CONFIG3	7:0		WDTE[1:0]			WDTCP5[4:0]		
		15:8			WDTCCS[2:0]		WDTCWS[2:0]		
0x300006	CONFIG4	7:0				WRT3	WRT2	WRT1	WRT0
		15:8		LVP	SCANE		WRTD	WRTB	WRTC
0x300008	CONFIG5	7:0						CPD	CP
		15:8							
0x30000A	CONFIG6	7:0				EBTR3	EBTR2	EBTR1	EBTR0
		15:8						EBTRB	

### 3.7 Register Definitions: Configuration Words

## PIC18(L)F24/25K40 Memory Organization

Figure 10-1. Program and Data Memory Map

Address	Device				
	PIC18(L)F4K40	PIC18(L)F25/45K40	PIC18(L)F65K40	PIC18(L)F6K40	PIC18(L)F7K40
<b>Note 1</b>	Stack (31 Levels)				
00 0000h	Reset Vector				
...	...				
00 0008h	Interrupt Vector High				
...	...				
00 0018h	Interrupt Vector Low				
...	...				
00 001Ah to 00 3FFFh	Program Flash Memory (8 KW)	Program Flash Memory (16 KW)	Program Flash Memory (16 KW)	Program Flash Memory (32 KW)	Program Flash Memory (64 KW)
00 4000h to 00 7FFFh	Not Present <sup>(2)</sup>	Not Present <sup>(2)</sup>	Not Present <sup>(2)</sup>	Not Present <sup>(2)</sup>	Not Present <sup>(2)</sup>
00 8000h to 00 FFFFh					
01 0000h to 01 FFFFh					
02 0000h to 1F FFFFh					
20 0000h to 20 000Fh	User IDs (8 Words) <sup>(3)</sup>				
20 0010h to 2F FFFFh	Reserved				
30 0000h to 30 000Bh	Configuration Words (6 Words) <sup>(3)</sup>				
30 000Ch to 30 FFFFh	Reserved				
31 0000h to 31 00FFh	Data EEPROM (256 Bytes)	Data EEPROM (1024 Bytes)			
31 0100h to 31 01FFh	Unimplemented				
30 000Ch to 30 FFFFh	Reserved				
3F FFFCh to 3F FFFDh	Revision ID (1 Word) <sup>(4)</sup>				
3F FFFEh to 3F FFFFh	Device ID (1 Word) <sup>(4)</sup>				

**Note 1:** The stack is a separate SRAM panel, apart from all user memory panels.

**2:** The addresses do not roll over. The region is read as '0'.

**3:** Not code-protected.

**4:** Device/Revision IDs are hard-coded in silicon.

## PIC18(L)F24/25K40 Memory Organization

Figure 10-2. Memory Map and Code Protection Control

Region	Address	Device						
		PIC18(L)F4K40	PIC18(L)F25/45K40	PIC18(L)F65K40	PIC18(L)F6K40	PIC18(L)F7K40		
PFM	00 0000h to 00 07FFh	Boot Block 1 KW CP, WRTB, EBTRB	Boot Block 1 KW CP, WRTB, EBTRB	Boot Block 1 KW CP, WRTB, EBTRB	Boot Block 1 KW CP, WRTB, EBTRB	Boot Block 1 KW CP, WRTB, EBTRB		
	00 0800h to 00 1FFFh	Block 0 3 KW CP, WRT0, EBTR0	Block 0 3 KW CP, WRT0, EBTR0	Block 0 3 KW CP, WRT0, EBTR0	Block 0 7 KW CP, WRT0, EBTR0	Block 0 7 KW CP, WRT0, EBTR0		
	00 2000h to 00 3FFFh	Block 1 4 KW CP, WRT1, EBTR1	Block 1 4 KW CP, WRT1, EBTR1	Block 1 4 KW CP, WRT1, EBTR1				
	00 4000h to 00 5FFFh	Not Present	Block 2 4 KW CP, WRT2, EBTR2	Block 2 4 KW CP, WRT2, EBTR2	Block 1 8 KW CP, WRT1, EBTR1	Block 1 8 KW CP, WRT1, EBTR1		
	00 6000h to 00 7FFFh		Block 3 4 KW CP, WRT3, EBTR3	Block 3 4 KW CP, WRT3, EBTR3				
	00 8000h to 00 BFFFh		Block 2 8 KW CP, WRT2, EBTR2		Block 2 8 KW CP, WRT2, EBTR2	Block 2 8 KW CP, WRT2, EBTR2		
	00 C000h to 00 FFFFh		Block 3 8 KW CP, WRT3, EBTR3		Block 3 8 KW CP, WRT3, EBTR3	Block 3 8 KW CP, WRT3, EBTR3		
	01 0000h to 01 3FFFh		Not Present	Not Present	Not Present	Block 4 8 KW CP, WRT4, EBTR4		
	01 4000h to 01 7FFFh					Block 5 8 KW CP, WRT5, EBTR5		
	01 8000h to 01 BFFFh					Block 6 8 KW CP, WRT6, EBTR6		
	01 C000h to 01 FFFFh					Block 7 8 KW CP, WRT7, EBTR7		
	CONFIG		30 0000h to 30 000Bh	6 Words WRTC				
	Data EEPROM		31 0000h to 31 00FFh	256 Words CPD, WRTD		1 KW CPD, WRTD		
		31 0100h to 31 01FFh	Unimplemented					



# MCP7940M

## Low-Cost I<sup>2</sup>C Real-Time Clock/Calendar with SRAM

### Timekeeping Features

- Real-Time Clock/Calendar (RTCC):
  - Hours, Minutes, Seconds, Day of Week, Day, Month, Year
  - Leap year compensated to 2399
  - 12/24 hour modes
- Oscillator for 32.768 kHz Crystals:
  - Optimized for 6-9 pF crystals
- On-Chip Digital Trimming/Calibration:
  - $\pm 1$  PPM resolution
  - $\pm 129$  PPM range
- Dual Programmable Alarms
- Versatile Output Pin:
  - Clock output with selectable frequency
  - Alarm output
  - General purpose output

### Low-Power Features

- Wide Voltage Range:
  - Operating voltage range of 1.8V to 5.5V
- Low Typical Timekeeping Current:
  - Operating from V<sub>CC</sub>: 1.2  $\mu$ A at 3.3V

### User Memory

- 64-byte SRAM

### Operating Ranges

- 2-Wire Serial Interface, I<sup>2</sup>C Compatible
  - I<sup>2</sup>C clock rate up to 400 kHz
- Temperature Range:
  - Industrial (I): -40°C to +85°C

### Packages:

- 8-Lead SOIC, MSOP, TSSOP, PDIP and 2x3 TDFN

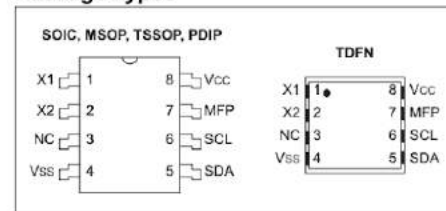
### General Description

The MCP7940M Real-Time Clock/Calendar (RTCC) tracks time using internal counters for hours, minutes, seconds, days, months, years, and day of week. Alarms can be configured on all counters up to and including months. For usage and configuration, the MCP7940M supports I<sup>2</sup>C communications up to 400 kHz.

The open-drain, multi-functional output can be configured to assert on an alarm match, to output a selectable frequency square wave, or as a general purpose output.

The MCP7940M is designed to operate using a 32.768 kHz tuning fork crystal with external crystal load capacitors. On-chip digital trimming can be used to adjust for frequency variance caused by crystal tolerance and temperature.

### Package Types



## MCP7940M

**TABLE 4-1: DETAILED RTCC REGISTER MAP**

Addr.	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
<b>Section 4.3 "Timekeeping"</b>									
00h	RTCSEC	ST	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
01h	RTCMIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
02h	RTCHOUR	—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
03h	RTCWKDAY	—	—	OSCRUN	—	—	WKDAY2	WKDAY1	WKDAY0
04h	RTCDATE	—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
05h	RTCMTH	—	—	LPYR	MHTTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
06h	RTCYEAR	YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0
07h	CONTROL	OUT	SQWEN	ALM1EN	ALM0EN	EXTOSC	CRSTRIM	SQWFS1	SQWFS0
08h	OSCTRIM	SIGN	TRIMVAL6	TRIMVAL5	TRIMVAL4	TRIMVAL3	TRIMVAL2	TRIMVAL1	TRIMVAL0
09h	Reserved	Reserved – Do not use							
<b>Section 4.4 "Alarms"</b>									
0Ah	ALM0SEC	—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
0Bh	ALM0MIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
0Ch	ALM0HOUR	—	12/24 <sup>(2)</sup>	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
0Dh	ALM0WKDAY	ALMPOL	ALM0MSK2	ALM0MSK1	ALM0MSK0	ALM0IF	WKDAY2	WKDAY1	WKDAY0
0Eh	ALM0DATE	—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
0Fh	ALM0MTH	—	—	—	MHTTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
10h	Reserved	Reserved – Do not use							
<b>Section 4.4 "Alarms"</b>									
11h	ALM1SEC	—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
12h	ALM1MIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
13h	ALM1HOUR	—	12/24 <sup>(2)</sup>	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
14h	ALM1WKDAY	ALMPOL <sup>(3)</sup>	ALM1MSK2	ALM1MSK1	ALM1MSK0	ALM1IF	WKDAY2	WKDAY1	WKDAY0
15h	ALM1DATE	—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
16h	ALM1MTH	—	—	—	MHTTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
17h-1Fh	Reserved	Reserved – Do not use							

**Note 1:** Grey areas are unimplemented.

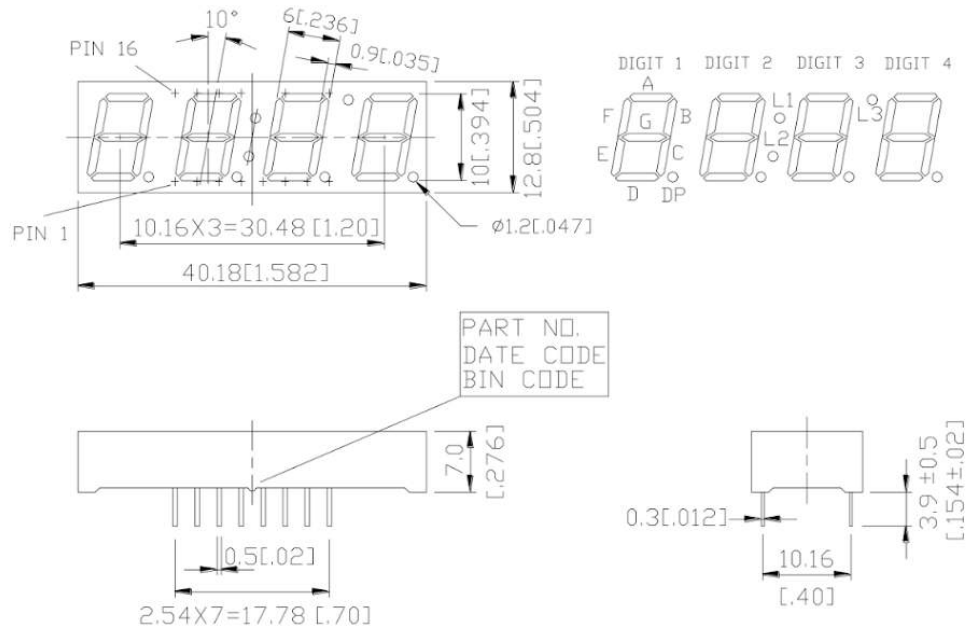
- 2:** The 12/24 bits in the ALMxHOUR registers are read-only and reflect the value of the 12/24 bit in the RTCHOUR register.
- 3:** The ALMPOL bit in the ALM1WKDAY register is read-only and reflects the value of the ALMPOL bit in the ALM0WKDAY register.



**LITE-ON TECHNOLOGY CORPORATION**

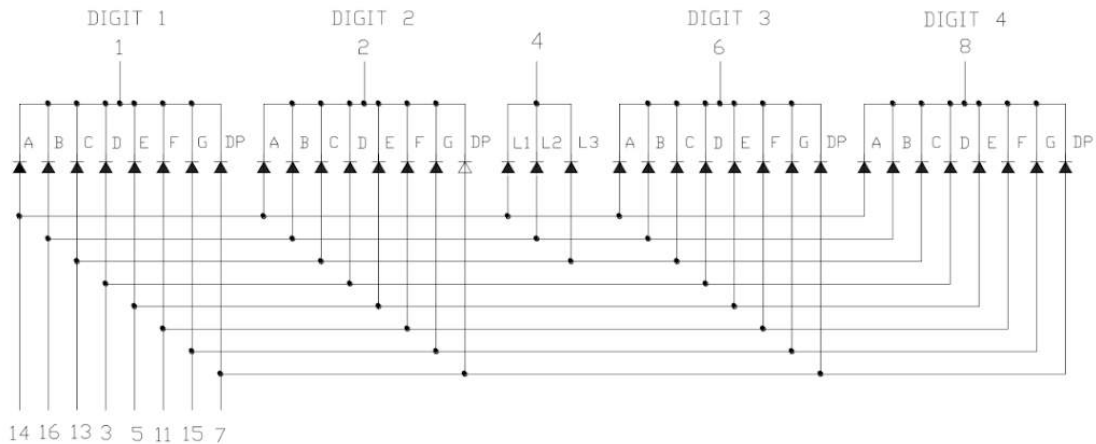
Property of Lite-On Only

**PACKAGE DIMENSIONS**



NOTES: All dimensions are in millimeters. Tolerances are ± 0.25 mm (0.01") unless otherwise noted.

**INTERNAL CIRCUIT DIAGRAM**



PART NO.: LTC-4727JR

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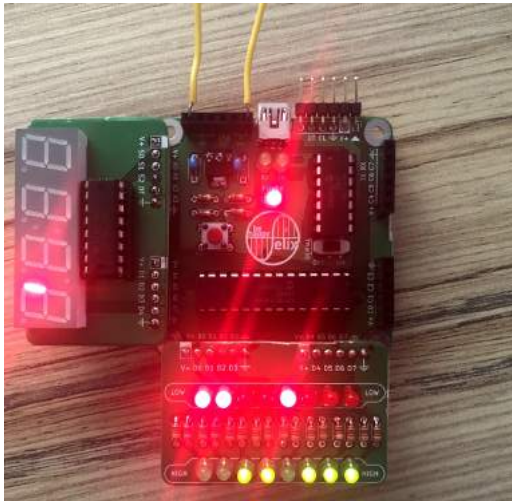
## APPENDIX D: Test Protocols

### Four Digit Seven Segment Display

Date Tested: 28 November 2018

Tested By: Ryan Michael Norton

The LED array and 4x7 segment display were tested in unison. With the controller configured to have registers A and B as outputs, a script was developed to push specific values to both LATA and LATB, cycling through all the segments on the 4x7 segment display and showing the raw inputs to that display on the LED array.



main.c

```
#include "mcc_generated_files/mcc.h"
void main(void)
{
    // Initialize the device
    SYSTEM_Initialize();

    LATA = 0;
    LATB = 0;

    uint8_t port = 0;
    while (1) {
        for (uint8_t digit = 0; digit < 5; digit++) {
            for (uint8_t segment = 0; segment < 8; segment++) {
                port = 0x01;
                port = port << (digit + 3);

                port |= 0x07 & ~segment;
                port = ~port;

                LATA = port;
                LATB = port;
                __delay_ms(100);
            }
        }
    }
}
```

```

    }
  }
}

```

The code was written to cycle through each segment of the display, which can be controlled according to the following diagram. Pins 0-2 representing a 3 bit number that determines which segment is active on a given digit (A-G and dot). Pins 3-7 are directly connected to the ground pins of the five digits (4 numeric, one for extra dots) and are active when low. If a digit is not supposed to be displayed, the associated pin should be held high so no voltage drop is present across undesired LEDs.

Pin	Rx0	Rx1	Rx2	Rx3	Rx4	Rx5	Rx6	Rx7
Function	Decoder Input 0	Decoder Input 1	Decoder Input 2	Digit Dots	Digit 0	Digit 1	Digit 2	Digit 3
Active	High	High	High	Low	Low	Low	Low	Low

The delay in the code is so that individual LED segments can be observed lighting up to confirm individual control, and therefore multiplexing are possible. As the delay is lowered and then removed, all segments appear to be active, even if dimmer.

Conclusion: The LED array and 4x7 segment display function as desired. The green LEDs on the array are certainly dimmer than the red ones, and attention is drawn to the red. It should be considered to use only red LEDs for this specific module, but subject testing will be required to be sure.

### EUSART to USB Bridge Test

Date Tested: 7 November 2018

Tested By: Ryan Michael Norton

After configuring the serial port using the MCC tool in MPLAB X, a script was written to display the classic “Hello, World!” repeatedly on the serial port. The code was flashed and then the USB port connected to a laptop. The serial port at the designated baud rate was opened in the Arduino IDE for simplicity and “Hello, World!” was repeatedly displayed on the screen.

```

main.c
#include "mcc_generated_files/mcc.h"
void main(void)
{
  // Initialize the device
  SYSTEM_Initialize();

  while (1)

```

```

{
  // Add your application code
  char str[] = "Hello, World!\n";
  for (int i=0; i<14; i++) {
    EUSART_Write(str[i]);
  }
}
}
}

```

Conclusion: MCP2221 serial bridge and PIC18F24K40 hardware serial port both function without issue.

### LED Current Consumption Test

Date Tested: 18 November 2018

Tested By: Ryan Michael Norton

#### *4x7 Segment Display*

Multimeter: INNOVA 3320 Auto-Ranging Digital Multimeter

Display: LTC-4727JR (Part No. 160-1551-5-ND)

Decoder: CD74HC238E (Part No. 296-25983-5-ND)

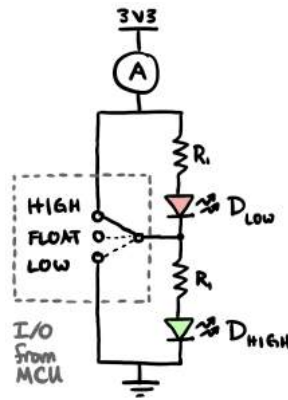
Current was tested by connecting a single LED segment to a 3.3 V regulated power supply in line with an ammeter, decoder, and listed resistance. Visibility was noted by multiplexing through all possible segments using the prototype Felix controller version 1.0.

Nominal Resistance [ohm]	Measured Resistance [ohm]	Current Consumption [mA]	Visibility at Full Multiplexing
1k	986.0	1.56	Hardly visible
220	119.2	5.53	Somewhat visible
0 (short)	0 (short)	16.01	Comfortably visible

Conclusion: By taking advantage of the decoders output current limiting feature, no resistors on display produces the best results and is below the displays continuous forward current of 25 mA (see datasheet for LTC-4727JR in appendix).

#### *LED Array Module*

The following circuit was constructed and connected in the states listed in the table below. It represents a single unit of the LED array. Current through the ammeter (shown in schematic) was measured and visibility of each LED noted.



Input Pin State (TTL tristate)	Nominal Resistance [ohm]	Measured Resistance [ohm]	Current Consumption [mA]	Red Visibility	Green Visibility
High (~3.3 V)	1k	986	1.64	On	Off
	220	119.2	7.08	On	Off
Low (0 V)	1k	986	1.51	Off	On (Dim)
	220	119.2	6.27	Off	On
Not Connected (Floating)	1k	986	0.03	Barely On	Off
	220	119.2	0.06	Barely On	Off

Conclusion: While 220 ohm resistance produces a better user experience result, it comes at the cost of higher current consumption and having to source resistors of multiple values when everything else relies on 1k only. Even though the 220 ohm resistor uses more current, its still below the maximum forward current rating for both LEDs at 30 mA for both. Based on this, it is nominal to use 1k ohm resistors for the array.

### Potentiometer Test

Date Tested: 7 November 2018

Tested By: Ryan Michael Norton

Code was written to connect the potentiometer pin to an ADC channel and export the received value to the serial port. After connecting the USB port to a laptop and opening the serial port using the Arduino IDE, turning the knob resulted in values ranging from 0 to 255.

main.c

```

#include "mcc_generated_files/mcc.h"
#include <math.h>
void main(void)
{
    SYSTEM_Initialize();

    ADPCH = 0b000000;
    ADCON0bits.ADFM = 0;
    ADCON0bits.ADON = 1;

    while (1) {
        ADCON0bits.ADGO = 1;
        while (ADCON0bits.ADGO == 1);
        PORTB = ADRESH;
        __delay_us(600);

        uint8_t result = ADRESH;
        char newline = '\r';
        uint8_t dig[] = {0, 0, 0};
        dig[1] = result % 10;
        result = (result - dig[1]) / 10;

        dig[2] = result % 10;
        result = (result - dig[2]) / 10;

        dig[3] = result;

        dig[1] += 48;
        dig[2] += 48;
        dig[3] += 48;

        EUSART_Write(dig[3]);
        __delay_ms(10);
        EUSART_Write(dig[2]);
        __delay_ms(10);
        EUSART_Write(dig[1]);
        __delay_ms(10);
        EUSART_Write(newline); // new line
        __delay_ms(10);
    }
}

```

Conclusion: Potentiometer works as designed.

### Real Time Clock Test

Date Tested: 28 November 2018

Tested By: Ryan Michael Norton

Using the Arduino code generated by Kevin Darrah, code was ported to C in order to communicate with the real time clock module. MCC generated code was used to facilitate the

I2C protocol in hardware. Specialized functions were written to export data to the serial port in certain formats (strings, hexadecimal, etc).

A test time was loaded into the clock module at start and the real time clock was occasionally polled to determine the time. The time was then formatted and displayed on the serial port. An timer was set for 24 hours on a cell phone and the reset button hit just as the timer was started. When the timer went off the times were compared and not a second had been missed.

```

main.c
#include "mcc_generated_files/mcc.h"

#define RTCSEC    0x00
#define RTCMIN    0x01
#define RTCHOUR   0x02
#define RTCWKDAY  0x03
#define RTCDATE   0x04
#define RTCMTH    0x05
#define RTCYEAR   0x06
#define CONTROL   0x07
#define OSCTRIM   0x08
#define ALMOSEC   0x0A
#define ALMOMIN   0x0B
#define ALM0HOUR  0x0C
#define ALM0WKDAY 0x0D
#define ALM0DATE  0x0E
#define ALM0MTH   0x0F
#define ALM1SEC   0x11
#define ALM1MIN   0x12
#define ALM1HOUR  0x13
#define ALM1WKDAY 0x14
#define ALM1DATE  0x15
#define ALM1MTH   0x16
#define PWRDNMIN  0x18
#define PWRDNHOUR 0x19
#define PWRDNDATE 0x1A
#define PWRDNMTH  0x1B
#define PWRUPMIN  0x1C
#define PWRUPHOUR 0x1D
#define PWRUPDATE 0x1E
#define PWRUPMTH  0x1F

#define RTC      0xDE >> 1

char hex[] = "0123456789ABCDEF";
void print(uint8_t data) {
    EUSART_Write(data);
}
void printh (uint8_t data) { // print hexadecimal
    print('0');
    print('x');
    print(hex[data >> 4]);
    print(hex[data & 0x0F]);
}
void printn (uint8_t data) {
    data += 48;
    print(data);
}
void printl (char *str[]) {

```

```

    for (uint8_t index = 0; index < sizeof(str); index++) {
        print(str[index]);
    }
}
void println (char *str[]) {
    printl(str);
    print("\n");
}

I2C1_MESSAGE_STATUS pflag;
uint8_t buffer[2];

void write(uint8_t addr, uint8_t reg, uint8_t val) {
    buffer[0] = reg;
    buffer[1] = val;

    I2C1_MasterWrite (&buffer, 2, addr, &pflag);
    while(pflag == I2C1_MESSAGE_PENDING);
}

uint8_t read (uint8_t addr, uint8_t reg, uint8_t length) {
    buffer[0] = reg;
    buffer[1] = 0x00;

    I2C1_MasterWrite (&buffer, 1, addr, &pflag);
    while(pflag == I2C1_MESSAGE_PENDING);

    I2C1_MasterRead (&buffer, 1, addr, &pflag);
    while(pflag == I2C1_MESSAGE_PENDING);

    return buffer[0];
}

uint8_t seconds;
uint8_t minutes;
uint8_t hours;
uint8_t weekday;
uint8_t day;
uint8_t month;
uint8_t year;
uint8_t pm;

void getTime () {
    seconds = read(RTC,RTCSEC, 1);
    minutes = read(RTC,RTCMIN, 1);
    hours = read(RTC,RTCHOUR, 1);
    weekday = read(RTC,RTCWKDAY,1);
    day = read(RTC,RTCDATE, 1);
    month = read(RTC,RTCMTH, 1);
    year = read(RTC,RTCYEAR, 1);
}

char dow[7] = "UMTWRFs";
void printTime () {
    seconds &= 0x7F;
    minutes &= 0x7F;
    hours &= 0x7F;
    weekday &= 0x07;
    day &= 0x1F;
    month &= 0x1F;

    printn((hours >> 4) & 0x01);
    printn(hours & 0x0F);
    print(':');
    printn(minutes >> 4);
}

```

```

    printn(minutes & 0x0F);
    print(':');
    printn(seconds >> 4);
    printn(seconds & 0x0F);
    print(' ');
    if (((hours >> 5) & 0x01) == 1) {
        print('P');
    } else {
        print('A');
    }
    print('M');
    print(' ');
    print(dow[(weekday & 0x07) -1]);
    print(' ');
    printn((day >> 4) & 0xFF);
    printn(day & 0x0F);
    print('/');
    printn(month>>4 & 0x01);
    printn(month & 0x0F);
    print('/');
    printn(year >> 4) & 0xFF);
    printn(year & 0x0F);
    print('\n');
}

uint8_t bin2bcd (uint8_t binary) {
    uint8_t low = 0;
    uint8_t high = 0;

    if (binary > 99) {
        binary = 99;
    }

    low = binary % 8;
    binary -= low;
    high = binary / 10;

    return (high << 4) | low;
}

uint8_t value;
void rtc_init() {
    write(RTC,CONTROL,0x00);

    value = read(RTC,RTCHOUR,1) | 0x40;
    write(RTC,RTCHOUR,value);

    value = read(RTC,RTCWKDAY,1) | 0x08;
    write(RTC,RTCWKDAY,value);

    value = read(RTC,RTCSEC,1) | 0x80;
    write(RTC,RTCSEC,value);
}

void set_time () {
    value = read(RTC,RTCSEC,1) | ((bin2bcd(seconds) & 0x7F));
    printh(value);
    write(RTC,RTCSEC,value);

    value = read(RTC,RTCMIN,1) | ((bin2bcd(minutes) & 0x7F));
    printh(value);
    write(RTC,RTCMIN,value);

    hours = bin2bcd(hours) | pm << 5;
    value = read(RTC,RTCHOUR,1) | (hours & 0x3F);
}

```

```
    printh(value);
    write(RTC,RTCHOUR,value);
}

void main(void)
{
    SYSTEM_Initialize();
    INTERRUPT_GlobalInterruptEnable();
    INTERRUPT_PeripheralInterruptEnable();

    __delay_ms(5000);
    for (int i = 0; i<20; i++) {
        print(':');
        __delay_ms(100);
    }

    seconds = 00;
    minutes = 12;
    hours = 04;
    pm = 1;

    set_time();

    rtc_init();

    uint8_t n = 0;

    while (1) {
        getTime();
        printTime();
    }

    while (1) {

        if (n % 8 == 0) {
            if (n == 0) {
                print('\n');
                getTime();
                printTime();

                print('\n');
                __delay_ms(1000);
            }
            print('\n');
            printh(n);
            print('\t');
            print('-');
            print('-');
            print('>');
        }
        print('\t');
        printh(read(RTC,n,1));

        n++;
        if (n > 0x1F) n = 0x00;
    }
}
```

Conclusion: As the real time clock was able to stably keep time over a 24 hour period, it is reasonable to conclude that its other capabilities function as desired and that the module is stable enough for educational use.

### Rotary Encoder Test

Date Tested: 7 November 2018

Tested By: Ryan Michael Norton

Code was written to connect the rotary encoder pins to external interrupts and increment a register value displayed by the LED array on Port B. After uploading the code, the device was successfully able to increment and decrement the register value using the rotary capability.

```
main.c
#include "mcc_generated_files/mcc.h"
#include <math.h>

char value = 128;

void rotA (void) {
    if (PORTAbits.RA5) {
        value++;
    } else {
        value--;
    }
}

void main(void) {
    SYSTEM_Initialize();
    INT0_AttachInterrupt(rotA);
    while (1) {
        LATB = value;
    }
}
```

Conclusion: Rotary encoder works as designed.

### SMD LDO Soldering Test

Date Tested: 9 November 2018

Tested By: Ryan Michael Norton

The subject was given a rudimentary soldering iron, solder, an empty controller board, and the SMD LDO. The subject was instructed to solder the regulator to the board. The subject was recorded being given instructions and soldering the regulator on. Experimenter was present and answered questions the subject had during the process. After the subject was comfortable with the job, the regulator was connected to a 5V power supply and the voltage measured.

Test Subject: Laura Stegner

Limited previous soldering experience. No surface mounted soldering experience.

See *SMD LDO Soldering Test - Soldering.mov* and *SMD LDO Soldering Test - Validation.mov* for more details.

Conclusion: SMD LDO is large enough to be soldering by amateurs successfully.